

# PIC32

# **PIC32 Flash Programming Specification**

# 1.0 DEVICE OVERVIEW

This document defines the programming specification for the PIC32 families of 32-bit microcontrollers. This programming specification is designed to guide developers of external programmer tools. Customers who are developing applications for PIC32 devices should use development tools that already provide support for device programming.

The major topics of discussion include:

- Section 1.0 "Device Overview'
- Section 2.0 "Programming Overview"
- Section 3.0 "Programming Steps"
- Section 4.0 "Connecting to the Device"
- Section 5.0 "EJTAG vs. ICSP"
- Section 6.0 "Pseudo Operations"
- Section 7.0 "Entering 2-Wire Enhanced ICSP Mode"
- Section 8.0 "Check Device Status"
- Section 9.0 "Erasing the Device"
- Section 10.0 "Entering Serial Execution Mode"
   Section 14.0 "Describes the Breamsmine File
- Section 11.0 "Downloading the Programming Executive (PE)"
  Section 12.0 "Downloading a Data Block"
- Section 12.0 Downloading a Data Block
   Section 13.0 "Initiating a Flash Row Write"
- Section 13.0 Initiating a hash now
   Section 14.0 "Verify Device Memory"
- Section 15.0 "Exiting Programming Mode"
- Section 16.0 "The Programming Executive"
- Section 17.0 "Checksum"
- Section 18.0 "Configuration Memory and Device ID"
- Section 19.0 "TAP Controllers"
- Section 20.0 "AC/DC Characteristics and Timing Requirements"
- Appendix A: "PIC32 Flash Memory Map"
- Appendix B: "Hex File Format"
- Appendix C: "Revision History"

# 2.0 PROGRAMMING OVERVIEW

All PIC32 devices can be programmed through two primary methods:

- · Self-programming
- · External tool programming

The self-programming method requires that the target device already contains executable code with the logic necessary to complete the programming sequence.

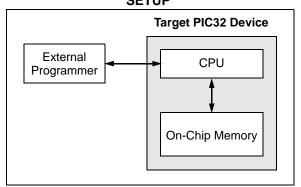
The external tool programming method does not require any code in the target device – it can program all target devices with or without any executable code.

This document describes the external tool programming method. Refer to the individual sections of the *"PIC32 Family Reference Manual"* and the specific device data sheet for more information about using the self-programming method.

An external tool programming setup consists of an external programmer tool and a target PIC32 device. Figure 2-1 illustrates the block diagram view of the typical programming setup. The programmer tool is responsible for executing necessary programming steps and completing the programming operation.

#### FIGURE 2-1:

PROGRAMMING SYSTEM SETUP



# 2.1 Devices with Dual Flash Panel and Dual Boot Regions

The PIC32MZ Embedded Connectivity (EC) family of devices incorporate several features useful for field (self) programming of the device. These features include dual Flash panels with dual Boot regions, an aliasing scheme for the Boot regions allowing automatic selection of Boot code at start-up and a panel swap feature for program Flash. The two Flash panels and their associated Boot regions can be erased and programmed separately. Refer to **Section 3. "Memory Organization"** (DS61115) in the *"PIC32 Family Reference Manual"* for a detailed explanation of these features.

A development tool used for production programming will not be concerned about most of these features with the following exceptions:

- Insuring that the SWAP bit (NVMCON<7>) is in the proper setting. The default setting is '0' for no swap of panels. The development tool should assume the default setting when generating source files for the programming tool.
- Proper handling of the aliasing of the Boot memory in the checksum calculation. The aliased sections will be duplicates of the fixed sections. See Section 17.0 "Checksum" for more information on checksum calculations with aliased regions.

# 2.2 Programming Interfaces

All PIC32 devices provide two physical interfaces to the external programmer tool:

- 2-wire In-Circuit Serial Programming<sup>™</sup> (ICSP<sup>™</sup>)
- 4-wire Joint Test Action Group (JTAG)

See **Section 4.0 "Connecting to the Device**" for more information.

Either of these methods may use a downloadable Programming Executive (PE). The PE executes from the target device RAM and hides device programming details from the programmer. It also removes overhead associated with data transfer and improves overall data throughput. Microchip has developed a PE that is available for use with any external programmer (see **Section 16.0 "The Programming Executive"** for more information).

**Section 3.0 "Programming Steps**" describes highlevel programming steps, followed by a brief explanation of each step. Detailed explanations are available in corresponding sections of this document.

More information on programming commands, EJTAG, and DC specifications are available in the following sections:

- Section 18.0 "Configuration Memory and Device ID"
- Section 19.0 "TAP Controllers"
- Section 20.0 "AC/DC Characteristics and Timing Requirements"

# 2.3 Enhanced JTAG (EJTAG)

The 2-wire and 4-wire interfaces use the EJTAG protocol to exchange data with the programmer. While this document provides a working description of this protocol as needed, advanced users are advised to refer to the *"EJTAG Specification"* (MD00047), which is available from MIPS Technologies, Inc. (www.mips.com).

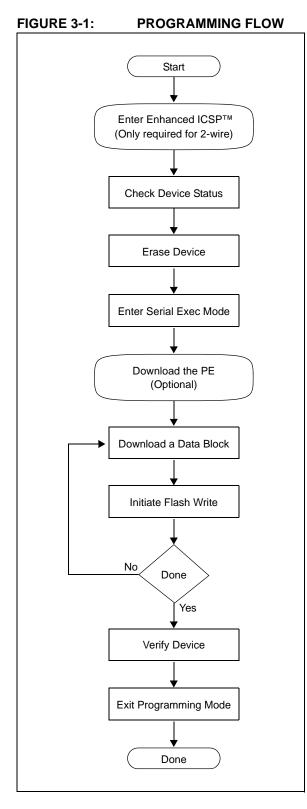
# 2.4 Data Sizes

Per the EJTAG Specification, data sizes are defined as follows:

- One Word: 32 bits
- One-half Word: 16 bits
- One-quarter Word: 8 bits
- One Byte: 8 bits

# 3.0 PROGRAMMING STEPS

All tool programmers must perform a common set of steps, regardless of the actual method being used. Figure 3-1 shows the set of steps to program PIC32 devices.



The following sequence lists the steps, with a brief explanation of each step. More detailed information about the steps is available in the following sections.

1. Connect to the Target Device.

To ensure successful programming, all required pins must be connected to appropriate signals. See **Section 4.0 "Connecting to the Device"** in this document for more information.

2. Place the Target Device in Programming Mode.

For 2-wire programming methods, the target device must be placed in a special programming mode (Enhanced ICSP<sup>TM</sup>) before executing any other steps.

Note:	For	the	4-wire	programming	methods,
	Step 2 is not required.				

See Section 7.0 "Entering 2-Wire Enhanced ICSP Mode" for more information.

3. Check the Status of the Device.

Step 3 checks the status of the device to ensure it is ready to receive information from the programmer.

See **Section 8.0 "Check Device Status**" for more information.

4. Erase the Target Device.

If the target memory block in the device is not blank, or if the device is code-protected, an erase step must be performed before programming any new data.

See **Section 9.0 "Erasing the Device**" for more information.

5. Enter Programming Mode.

Step 5 verifies that the device is not codeprotected and boots the TAP controller to start sending and receiving data to and from the PIC32 CPU.

See Section 10.0 "Entering Serial Execution Mode" for more information.

6. Download the Programming Executive (PE).

The PE is a small block of executable code that is downloaded into the RAM of the target device. It will receive and program the actual data.

Note: If the programming method being used does not require the PE, Step 6 is not required.

See Section 11.0 "Downloading the Programming Executive (PE)" for more information.

7. Download the Block of Data to Program.

All methods, with or without the PE, must download the desired programming data into a block of memory in RAM.

See Section 12.0 "Downloading a Data Block" for more information.

8. Initiate Flash Write.

After downloading each block of data into RAM, the programming sequence must be started to program it into the target device's Flash memory.

See Section 13.0 "Initiating a Flash Row Write" for more information.

9. Repeat Steps 7 and 8 until all data blocks are downloaded and programmed.

10. Verify the program memory.

After all programming data and Configuration bits are programmed, the target device memory should be read back and verified for the matching content.

See **Section 14.0 "Verify Device Memory"** for more information.

11. Exit the Programming mode.

The newly programmed data is not effective until either power is removed and reapplied to the target device or an exit programming sequence is performed.

See Section 15.0 "Exiting Programming Mode" for more information.

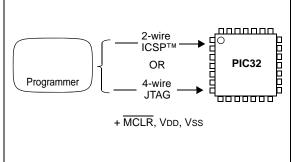
# 4.0 CONNECTING TO THE DEVICE

The PIC32 family provides two possible physical interfaces for connecting to and programming the memory contents (Figure 4-1). For all programming interfaces, the target device must be properly powered and all required signals must be connected. In addition, the interface must be enabled, either through its Configuration bit, as in the case of the JTAG 4-wire interface, or though a special initialization sequence, as is the case for the 2-wire ICSP interface.

The JTAG interface is enabled by default in blank devices shipped from the factory.

Enabling ICSP is described in Section 7.0 "Entering 2-Wire Enhanced ICSP Mode".





# 4.1 4-wire Interface

One possible interface is the 4-wire JTAG (IEEE 1149.1) port. Table 4-1 lists the required pin connections. This interface uses the following four communication lines to transfer data to and from the PIC32 device being programmed:

- TCK Test Clock Input
- TMS Test Mode Select Input
- TDI Test Data Input
- TDO Test Data Output

These signals are described in the following four sections. Refer to the specific device data sheet for the connection of the signals to the device pins.

# 4.1.1 TEST CLOCK INPUT (TCK)

TCK is the clock that controls the updating of the TAP controller and the shifting of data through the Instruction or selected Data register(s). TCK is independent of the processor clock with respect to both frequency and phase.

# 4.1.2 TEST MODE SELECT INPUT (TMS)

TMS is the control signal for the TAP controller. This signal is sampled on the rising edge of TCK.

# 4.1.3 TEST DATA INPUT (TDI)

TDI is the test data input to the Instruction or selected Data register(s). This signal is sampled on the rising edge of TCK for some TAP controller states.

# 4.1.4 TEST DATA OUTPUT (TDO)

TDO is the test data output from the Instruction or Data register(s). This signal changes on the falling edge of TCK. TDO is only driven when data is shifted out, otherwise the TDO is tri-stated.

Device Pin Name	Pin Type	Pin Description	
MCLR	I	Programming Enable	
ENVREG <sup>(2)</sup>	l	Enable for On-Chip Voltage Regulator	
VDD and AVDD <sup>(1)</sup>	Р	Power Supply	
Vss and AVss <sup>(1)</sup>	Р	Ground	
VCAP	Р	CPU logic filter capacitor connection	
TDI	I	Test Data In	
TDO	0	Test Data Out	
ТСК		Test Clock	
TMS		Test Mode State	
Legend: I = Input	O = Output	P = Power	

#### TABLE 4-1: 4-WIRE INTERFACE PINS

**Note 1:** All power supply and ground pins must be connected, including analog supplies (AVDD) and ground (AVss).

2: The ENVREG pin is not available on all devices. Please refer to the "**Pin Diagrams**" section in the specific device data sheet to determine availability.

# 4.2 2-wire Interface

Another possible interface is the 2-wire ICSP port. Table 4-2 lists the required pin connections. This interface uses the following two communication lines to transfer data to and from the PIC32 device being programmed:

- PGECx Serial Program Clock
- PGEDx Serial Program Data

These signals are described in the following two sections. Refer to the specific device data sheet for the connection of the signals to the chip pins.

# 4.2.1 SERIAL PROGRAM CLOCK (PGECX)

PGECx is the clock that controls the updating of the TAP controller and the shifting of data through the Instruction or selected Data register(s). PGECx is independent of the processor clock, with respect to both frequency and phase.

#### 4.2.2 SERIAL PROGRAM DATA (PGEDx)

PGEDx is the data input/output to the Instruction or selected Data Register(s), it is also the control signal for the TAP controller. This signal is sampled on the falling edge of PGECx for some TAP controller states.

Device Pin Name	Programmer Pin Name	Pin Type	Pin Description	
MCLR	MCLR	Р	Programming Enable	
ENVREG <sup>(2)</sup>	N/A	I	Enable for On-Chip Voltage Regulator	
VDD and AVDD <sup>(1)</sup>	Vdd	Р	Power Supply	
Vss and AVss <sup>(1)</sup>	Vss	Р	Ground	
VCAP	N/A	Р	CPU logic filter capacitor connection	
PGEC1	PGEC	I	Primary Programming Pin Pair: Serial Clock	
PGED1	PGED	I/O	Primary Programming Pin Pair: Serial Data	
PGEC2	PGEC	I	Secondary Programming Pin Pair: Serial Clock	
PGED2	PGED	I/O	Secondary Programming Pin Pair: Serial Data	
Legend: I = Inpu	ut	O = Output	P = Power	

#### TABLE 4-2: 2-WIRE INTERFACE PINS

Note 1: All power supply and ground pins must be connected, including analog supplies (AVDD) and ground (AVSS).

2: The ENVREG pin is not available on all devices. Please refer to either the "Pin Diagrams" or "Pin Tables" section in the specific device data sheet to determine availability.

# 4.3 **Power Requirements**

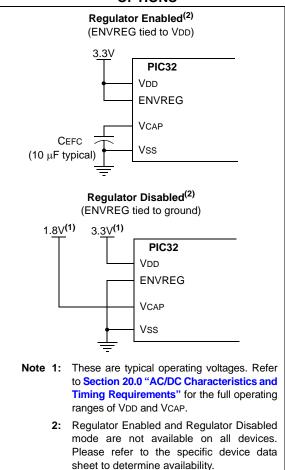
Devices in the PIC32 family are dual voltage supply designs. There is one supply for the core and another for peripherals and I/O pins. All devices contain an on-chip regulator for the lower voltage core supply to eliminate the need for an additional external regulator. There are three implementations of the on board regulator:

- The first version has an internal regulator that can be disabled using the ENVREG pin. When disabled, an external power supply must be used to power the core. If enabled, a low-ESR filter capacitor must be connected to the VCAP pin (see Figure 4-2).
- The second version has an internal regulator that cannot be disabled. A low-ESR filter capacitor must always be connected to the VCAP pin.
- The third version has an internal regulator that cannot be disabled and does not require a filter capacitor

Please refer to Section 20.0 "AC/DC Characteristics and Timing Requirements" and the "Electrical Characteristics" chapters in the specific device data sheet for the power requirements for your device.

# FIGURE 4-2:

#### INTERNAL REGULATOR ENABLE/DISABLE OPTIONS

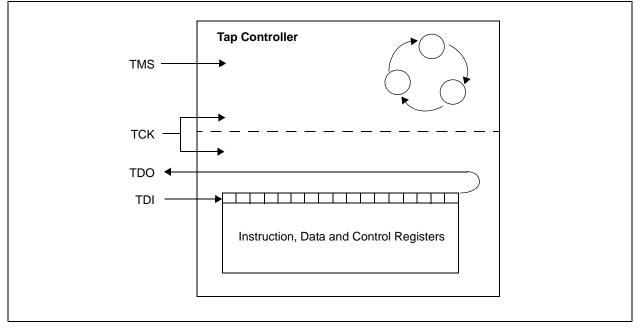


# 5.0 EJTAG vs. ICSP

Programming is accomplished through the EJTAG module in the CPU core. EJTAG is connected to either the full set of JTAG pins, or a reduced 2-wire to 4-wire EJTAG interface for ICSP mode. In both modes, programming of the PIC32 Flash memory is accomplished through the ETAP controller. The TAP Controller uses the TMS pin to determine if Instruction or Data registers should be accessed in the shift path between TDI and TDO (see Figure 5-1).

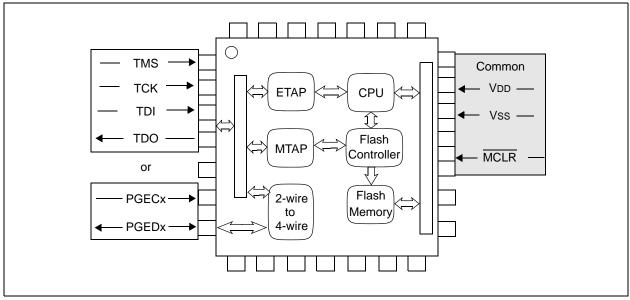
The basic concept of EJTAG that is used for programming is the use of a special memory area called DMSEG (0xFF200000 to 0xFF2FFFFF), which is only available when the processor is running in Debug mode. All instructions are serially shifted into an internal buffer, and then loaded into the Instruction register and executed by the CPU. Instructions are fed through the ETAP state machine in 32-bit groups.





# 5.1 **Programming Interface**

Figure 5-2 shows the basic programming interface in PIC32 devices. Descriptions of each interface block are provided in subsequent sections.



#### FIGURE 5-2: BASIC PIC32 PROGRAMMING INTERFACE BLOCK DIAGRAM

# 5.1.1 ETAP

This block serially feeds instructions and data into the CPU.

#### 5.1.2 MTAP

In addition to the EJTAG TAP (ETAP) controller, the PIC32 device uses a second proprietary TAP controller for additional operations. The Microchip TAP (MTAP) controller supports two instructions relevant to programming: MTAP\_COMMAND and TAP switch Instructions. See Table 19-1 for a complete list of Instructions. The MTAP\_COMMAND instruction provides a mechanism for a JTAG probe to send commands to the device through its Data register.

The programmer sends commands by shifting in the MTAP\_COMMAND instruction through the SendCommand pseudo operation, and then sending MTAP\_COMMAND DR commands through XferData pseudo operation (see Table 19-2 for specific commands).

The probe does not need to issue a  ${\tt MTAP\_COMMAND}$  instruction for every command shifted into the Data register.

#### 5.1.3 2-WIRE TO 4-WIRE

This block converts the 2-wire ICSP interface to the 4-wire JTAG interface.

# 5.1.4 CPU

The CPU executes instructions at 8 MHz through the internal oscillator.

# 5.1.5 FLASH CONTROLLER

The Flash controller controls erasing and programming of the Flash memory on the device.

# 5.1.6 FLASH MEMORY

The PIC32 device Flash memory is divided into two logical Flash partitions consisting of the Boot Flash Memory (BFM) and Program Flash Memory (PFM). The BFM begins at address 0x1FC00000, and the PFM begins at address 0x1D000000. Each Flash partition is divided into pages, which represent the smallest block of memory that can be erased. Depending on the device, page sizes are 256 words (1024 bytes), 1024 words (4096 bytes), or 4096 words (16,384 bytes). Row size indicates the number of words that are programmed with the row program command. There are always 8 rows within a page; therefore, devices with 256. 1024, and 4096 word page sizes have 32, 128, and 512 word row sizes, respectively. Table 5-1 shows the PFM, BFM, Row, and Page size of each device family.

The highest memory locations of the BFM are reserved for the device Configuration registers (see Section 18.0 "Configuration Memory and Device ID" for details).

TABLE 5-1:	CODE MEMORY SIZE
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PIC32 Device	Row Size (Words)	Page Size (Words)	Boot Flash Memory Address (Bytes)	Program Flash Memory Address (Bytes)
PIC32MX110F016B	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D003FFF (16 KB)
PIC32MX110F016C	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D003FFF (16 KB)
PIC32MX110F016D	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D003FFF (16 KB)
PIC32MX210F016B	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D003FFF (16 KB)
PIC32MX210F016C	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D003FFF (16 KB)
PIC32MX210F016D	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D003FFF (16 KB)
PIC32MX120F032B	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D007FFF (32 KB)
PIC32MX120F032C	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D007FFF (32 KB)
PIC32MX120F032D	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D007FFF (32 KB)
PIC32MX220F032B	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D007FFF (32 KB)
PIC32MX220F032C	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D007FFF (32 KB)
PIC32MX220F032D	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D007FFF (32 KB)
PIC32MX320F032H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D007FFF (32 KB)
PIC32MX420F032H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D007FFF (32 KB)
PIC32MX130F064B	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX130F064C	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX130F064D	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX230F064B	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX230F064C	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX230F064D	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX320F064H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX330F064H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX430F064H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX534F064H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX564F064H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX664F064H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX330F064L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX430F064L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX534F064L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX564F064L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX664F064L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D00FFFF (64 KB)
PIC32MX150F128B	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX150F128C	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX150F128D	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX250F128B	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX250F128C	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX250F128D	32	256	0x1FC00000-0x1FC00BFF (3 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX320F128H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX340F128H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX350F128H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX440F128H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX450F128H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX564F128H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX664F128H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX764F128H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX320F128L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX340F128L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)

PIC32 Device	Row Size (Words)	Page Size (Words)	Boot Flash Memory Address (Bytes)	Program Flash Memory Address (Bytes)
PIC32MX350F128L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX440F128L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX450F128L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX564F128L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX664F128L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX764F128L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D01FFFF (128 KB)
PIC32MX340F256H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX350F256H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX440F256H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX450F256H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX575F256H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX675F256H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX775F256H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX350F256L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX360F256L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX450F256L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX460F256L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX575F256L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX675F256L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX775F256L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MX340F512H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX360F512H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX370F512H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX440F512H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX470F512H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX575F512H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX675F512H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX695F512H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX775F512H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX795F512H	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX360F512L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX370F512L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX460F512L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX470F512L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX575F512L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX675F512L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX695F512L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX775F512L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MX795F512L	128	1024	0x1FC00000-0x1FC02FFF (12 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MZ0256ECE064	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MZ0256ECE100	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MZ0256ECE124	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MZ0256ECE144	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MZ0256ECF064	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MZ0256ECF100	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MZ0256ECF124	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D03FFFF (256 KB)
PIC32MZ0256ECF144	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D03FFFF (256 KB)

TABLE 5-1:	CODE MEMORY SIZE (CONTINUED)
------------	------------------------------

PIC32 Device	Row Size (Words)	Page Size (Words)	Boot Flash Memory Address (Bytes)	Program Flash Memory Address (Bytes)
PIC32MZ0512ECE064	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MZ0512ECE100	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MZ0512ECE124	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MZ0512ECE144	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MZ0512ECF064	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MZ0512ECF100	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MZ0512ECF124	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MZ0512ECF144	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D07FFFF (512 KB)
PIC32MZ1024ECE064	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECE100	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECE124	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECE144	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECF064	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECF100	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECF124	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECF144	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECG064	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECG100	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECG124	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECG144	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECH064	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECH100	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECH124	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ1024ECH144	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D0FFFFF (1024 KB)
PIC32MZ2048ECG064	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D1FFFFF (2048 KB)
PIC32MZ2048ECG100	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D1FFFFF (2048 KB)
PIC32MZ2048ECG124	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D1FFFFF (2048 KB)
PIC32MZ2048ECG144	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D1FFFFF (2048 KB)
PIC32MZ2048ECH064	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D1FFFFF (2048 KB)
PIC32MZ2048ECH100	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D1FFFFF (2048 KB)
PIC32MZ2048ECH124	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D1FFFFF (2048 KB)
PIC32MZ2048ECH144	512	4096	0x1FC00000-0x1FC13FFF (80 KB)	0x1D000000-0x1D1FFFFF (2048 KB)

# TABLE 5-1: CODE MEMORY SIZE (CONTINUED)

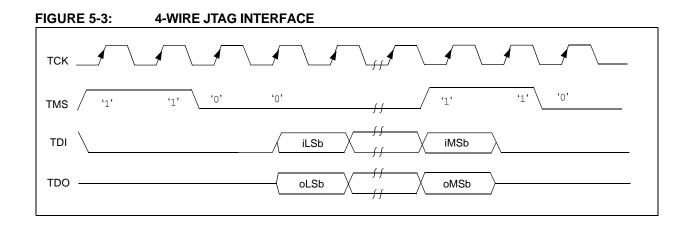
# 5.2 4-wire JTAG Details

The 4-wire interface uses standard JTAG (IEEE 1149.1-2001) interface signals.

- TCK: Test Clock drives data in/out
- TMS: Test Mode Select selects operational mode
- TDI: Test Data In data into the device
- TDO: Test Data Out data out of the device

Since only one data line is available, the protocol is necessarily serial (like SPI). The clock input is at the TCK pin. Configuration is performed by manipulating a state machine bit by bit through the TMS pin. One bit of data is transferred in and out per TCK clock pulse at the TDI and TDO pins, respectively. Different instruction modes can be loaded to read the chip ID or manipulate chip functions.

Data presented to TDI must be valid for a chip-specific setup time before, and hold time, after the rising edge of TCK. TDO data is valid for a chip-specific time after the falling edge of TCK (refer to Figure 5-3).



# 5.3 2-wire ICSP Details

In ICSP mode, the 2-wire ICSP signals are time multiplexed into the 2-wire to 4-wire block. The 2-wire to 4-wire block then converts the signals to look like a 4-wire JTAG port to the TAP controller.

There are two possible modes of operation:

- 4-phase ICSP
- 2-phase ICSP

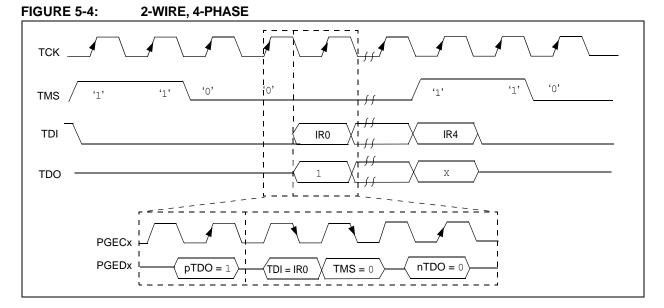
#### 5.3.1 4-PHASE ICSP

In 4-phase ICSP mode, the TDI, TDO and TMS device pins are multiplexed onto PGEDx in four clocks (see Figure 5-4). The Least Significant bit (LSb) is shifted first; and TDI and TMS are sampled on the falling edge of PGECx, while TDO is driven on the falling edge of PGECx. The 4-phase ICSP mode is used for both read and write data transfers.

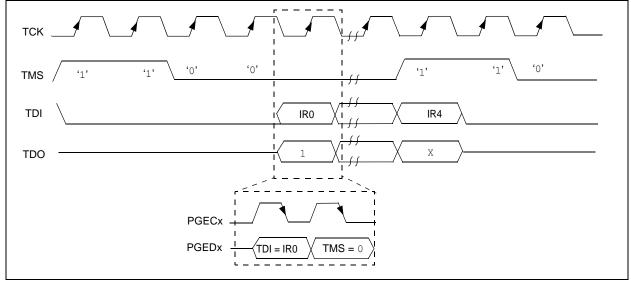
#### 5.3.2 2-PHASE ICSP

In 2-phase ICSP mode, the TMS and TDI device pins are multiplexed into PGEDx in two clocks (see Figure 5-5). The LSb is shifted first; and TDI and TMS are sampled on the falling edge of PGECx. There is no TDO output provided in this mode. The 2-phase ICSP mode was designed to accelerate 2-wire, write-only transactions.

Note: The packet is not actually executed until the first clock of the next packet. To enter 2-wire, 2-phase ICSP mode, the TDOEN bit (DDPCON<0>) must be set to '0'.



# FIGURE 5-5: 2-WIRE, 2-PHASE



# 6.0 **PSEUDO OPERATIONS**

To simplify the description of programming details, all operations will be described using pseudo operations. There are several functions used in the pseudocode descriptions. These are used either to make the pseudocode more readable, to abstract implementation-specific behavior, or both. When passing parameters with pseudo operation, the following syntax will be used:

- 5'h0x03 send 5-bit hexadecimal value of 3
- 6'b011111 send 6-bit binary value of 31

These functions are defined in this section, and include the following operations:

- SetMode (mode)
- SendCommand (command)
- oData = XferData (iData)
- oData = XferFastData (iData)
- oData = XferInstruction (instruction)

# 6.1 SetMode Pseudo Operation

Format:

SetMode (mode)

Purpose:

To set the EJTAG state machine to a specific state.

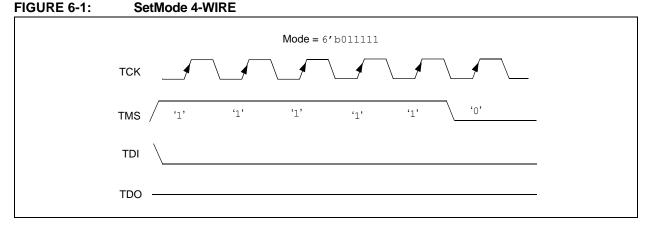
Description:

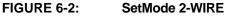
The value of mode is clocked into the device on signal TMS. TDI is set to a '0' and TDO is ignored.

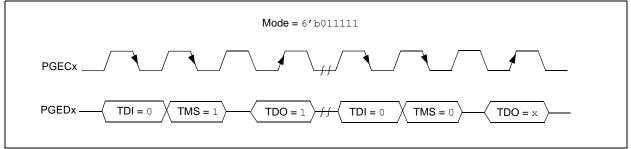
**Restrictions:** 

#### None. Example:

SetMode (6' b011111)







# 6.2 SendCommand Pseudo Operation

# Format:

SendCommand (command)

Purpose:

To send a command to select a specific TAP register.

Description (in sequence):

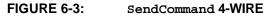
- 1. The TMS Header is clocked into the device to select the Shift IR state
- 2. The command is clocked into the device on TDI while holding signal TMS low.
- 3. The last Most Significant bit (MSb) of the command is clocked in while setting TMS high.
- 4. The TMS Footer is clocked in on TMS to return the TAP controller to the Run/Test Idle state.

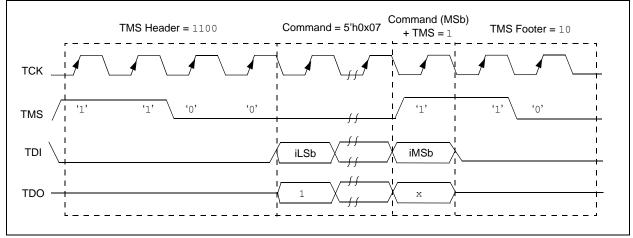
Restrictions:

None.

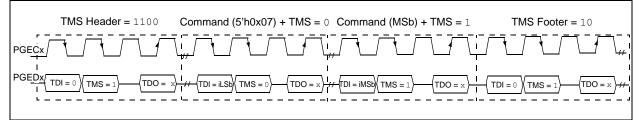
#### Example:

SendCommand (5'h0x07)





# FIGURE 6-4: SendCommand 2-WIRE (4-PHASE)



#### 6.3 XferData Pseudo Operation

Format:

oData = XferData (iData)

Purpose:

To clock data to and from the register selected by the command.

Description (in sequence):

- 1. The TMS Header is clocked into the device to select the Shift DR state.
- 2. The data is clocked in/out of the device on TDI/TDO while holding signal TMS low.
- 3. The last MSb of the data is clocked in/out while setting TMS high.
- 4. The TMS Footer is clocked in on TMS to return the TAP controller to the Run/Test Idle state.

**Restrictions:** 

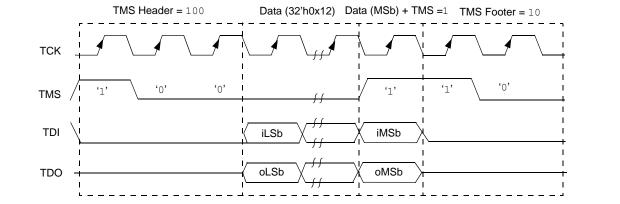
None.

Example:

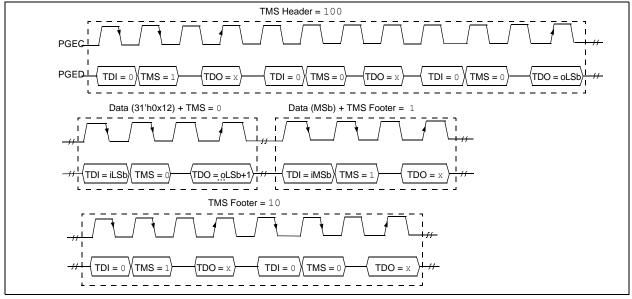
oData = XferData (32'h0x12)











# 6.4 XferFastData Pseudo Operation

#### Format:

oData = XferFastData (iData)

Purpose:

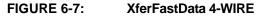
To quickly send 32 bits of data in/out of the device.

Description (in sequence):

1. The TMS Header is clocked into the device to select the Shift DR state.

Note: For 2-wire (4-phase) – on the last clock, the oPrAcc bit is shifted out on TDO while clocking in the TMS Header. If the value of oPrAcc is not '1', the whole operation must be repeated.

- 2. The input value of the PrAcc bit, which is '0', is clocked in.
  - Note: For 2-wire (4-phase) the TDO during this operation will be the LSb of output data. The rest of the 31 bits of the input data are clocked in and the 31 bits of output data are clocked out. For the last bit of the input data, the TMS Footer = 1 is set.
- 3. TMS Footer = 10 is clocked in to return the TAP controller to the Run/Test Idle state.



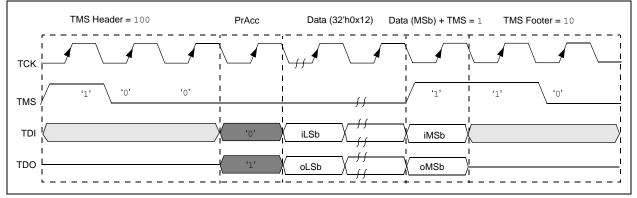
**Restrictions:** 

The SendCommand (ETAP\_FASTDATA) must be sent first to select the Fastdata register, as shown in Example 6-1. See Table 19-4 for a detailed descriptions of commands.

Note:	The 2-phase XferData is only used when					
	talking to the PE	E. See Section	<mark>ո 16.</mark> ն	) "The		
	Programming	Executive"	for	more		
	information.					

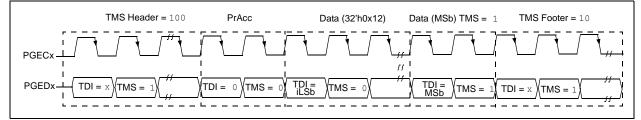
#### EXAMPLE 6-1: SendCommand

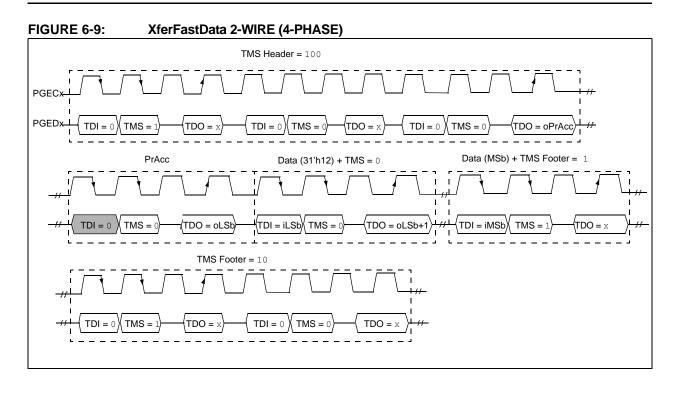
// Select the Fastdata Register SendCommand (ETAP\_FASTDATA) // Send/Receive 32-bit Data oData = XferFastData(32'h0x12)



#### FIGURE 6-8: X

XferFastData 2-WIRE (2-phase)





#### 6.5 XferInstruction Pseudo Operation

#### Format:

XferInstruction (instruction)

Purpose:

To send 32 bits of data for the device to execute.

Description:

The instruction is clocked into the device and then executed by CPU.

Restrictions: The device must be in Debug mode.

#### EXAMPLE 6-2: XferInstruction

```
XferInstruction (instruction)
{
   // Select Control Register
   SendCommand(ETAP CONTROL);
   // Wait until CPU is ready
   // Check if Processor Access bit (bit 18) is set
   do {
       controlVal = XferData(32'h0x0004C000);
   } while( PrAcc(contorlVal<18>) is not '1' );
   // Select Data Register
   SendCommand (ETAP DATA);
   // Send the instruction
   XferData(instruction);
   // Tell CPU to execute instruction
   SendCommand(ETAP CONTROL);
   XferData(32'h0x0000C000);
```

}

# 7.0 ENTERING 2-WIRE ENHANCED ICSP MODE

To use the 2-wire PGEDx and PGECx pins for programming, they must be enabled. Note that any pair of programming pins available on a particular device may be used, however, they must be used as a pair. PGED1 must be used with PGEC1, and so on.

**Note:** If using the 4-wire JTAG interface, the following procedure is not necessary.

The following steps are required to enter 2-wire Enhanced ICSP mode:

- 1. The  $\overline{\text{MCLR}}$  pin is briefly driven high, then low.
- 2. A 32-bit key sequence is clocked into PGEDx.
- 3. MCLR is then driven high within a specified period of time and held.

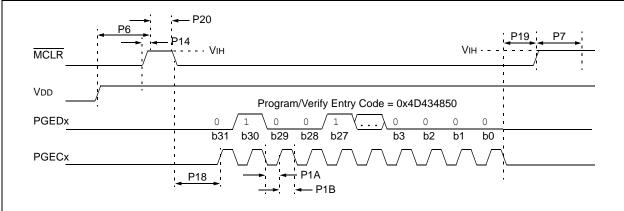
Please refer to Section 20.0 "AC/DC Characteristics and Timing Requirements" for timing requirements. The programming voltage applied to  $\overline{\text{MCLR}}$  is VIH, which is essentially VDD, in PIC32 devices. There is no minimum time requirement for holding at VIH. After VIH is removed, an interval of at least P18 must elapse before presenting the key sequence on PGEDx.

The key sequence is a specific 32-bit pattern: '0100 1101 0100 0011 0100 1000 0101 0000' (the acronym 'MCHP', in ASCII). The device will enter Program/Verify mode only if the key sequence is valid. The MSb of the Most Significant nibble must be shifted in first.

Once the key sequence is complete, VIH must be applied to MCLR and held at that level for as long as the 2-wire Enhanced ICSP interface is to be maintained. An interval of at least time P19 and P7 must elapse before presenting data on PGEDx. Signals appearing on PGEDx before P7 has elapsed will not be interpreted as valid.

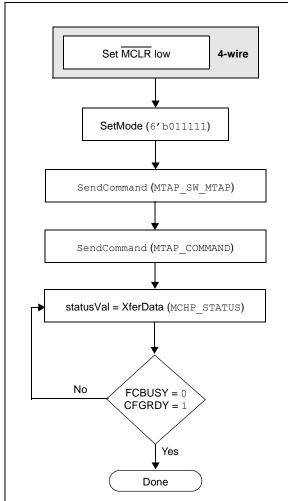
Upon successful entry, the programming operations documented in subsequent sections can be performed. While in 2-wire Enhanced ICSP mode, all unused I/Os are placed in the high-impedance state.





# 8.0 CHECK DEVICE STATUS

Before a device can be programmed, the programmer must check the status of the device to ensure that it is ready to receive information.



# 8.1 4-wire Interface

Four-wire JTAG programming is a Mission mode operation and therefore the setup sequence to begin programing should be done while asserting MCLR. Holding the device in Reset prevents the processor from executing instructions or driving ports.

The following steps are required to check the device status using the 4-wire interface:

- 1. Set MCLR pin low.
- 2. SetMode (6'b011111) to force the Chip TAP controller into Run Test/Idle state.
- 3. SendCommand (MTAP\_SW\_MTAP).
- 4. SendCommand (MTAP COMMAND).
- 5. statusVal = XferData (MCHP\_STATUS).
- 6. If CFGRDY (statusVal<3>) is not '1' and FCBUSY (statusVal<2>) is not '0' GOTO step 5.
  - Note: If using the 4-wire interface, the oscillator source, as selected by the Configuration Words, must be present to access flash memory. In an unprogrammed device, the oscillator source is the internal FRC allowing for flash memory access. If the Configuration Words have been reprogrammed selecting an external oscillator source then it must be present for flash memory access. See the "Special Features" chapter in the specific device data sheet for details regarding oscillator selection using the Configuration Word settings.

# 8.2 2-wire Interface

The following steps are required to check the device status using the 2-wire interface:

- 1. SetMode (6'b011111) to force the Chip TAP controller into Run Test/Idle state.
- 2. SendCommand (MTAP\_SW\_MTAP).
- 3. SendCommand (MTAP COMMAND).
- 4. statusVal = XferData (MCHP\_STATUS).
- If CFGRDY (statusVal<3>) is not '1' and FCBUSY (statusVal<2>) is not '0', GOTO step 4.

Note: If CFGRDY and FCBUSY do not come to the proper state within 10 ms, the sequence may have been executed incorrectly or the device is damaged.

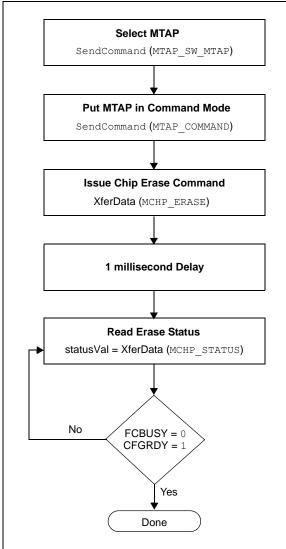
# 9.0 ERASING THE DEVICE

Before a device can be programmed, it must be erased. The erase operation writes all '1s' to the Flash memory and prepares it to program a new set of data. Once a device is erased, it can be verified by performing a "Blank Check" operation. See Section 9.1 "Blank Check" for more information.

The procedure for erasing program memory (Program, Boot, and Configuration memory) consists of selecting the MTAP and sending the MCHP\_ERASE command. The programmer then must wait for the erase operation to complete by reading and verifying bits in the MCHP\_STATUS value. Figure 9-1 illustrates the process for performing a Chip Erase.

Note: The Device ID memory locations are readonly and cannot be erased. Therefore, Chip Erase has no effect on these memory locations.

#### FIGURE 9-1: ERASE DEVICE



The following steps are required to erase a target device:

- 1. SendCommand (MTAP\_SW\_MTAP).
- 2. SendCommand (MTAP\_COMMAND).
- 3. XferData (MCHP ERASE).
- 4. Delay 1 ms.
- 5. statusVal = XferData (MCHP\_STATUS).
- If CFGRDY (statusVal<3>) is not '1' and FCBUSY (statusVal<2>) is not '0', GOTO to step 4.

```
Note: The Chip Erase operation is a self-timed operation. If the FCBUSY and CFGRDY bits do not become properly set within the specified Chip Erase time, the sequence may have been executed incorrectly or the device is damaged.
```

# 9.1 Blank Check

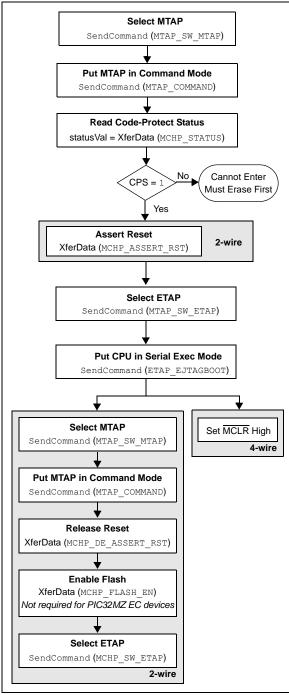
The term "Blank Check" implies verifying that the device has been successfully erased and has no programmed memory locations. A blank or erased memory location always reads as '1'.

The device Configuration registers are ignored by the Blank Check. Additionally, all unimplemented memory space should be ignored from the Blank Check.

# 10.0 ENTERING SERIAL EXECUTION MODE

Before a device can be programmed, it must be placed in Serial Execution mode. The procedure for entering Serial Execution mode consists of verifying that the device is not code-protected. If the device is code-protected, a Chip Erase must be performed. See Section 9.0 "Erasing the Device" for details.

# FIGURE 10-1: ENTERING SERIAL EXECUTION MODE



# 10.1 4-wire Interface

The following steps are required to enter Serial Execution mode:

Note:	It is assumed that MCLR has been driven		
	low from the previous Check Device		
	Status step (see Figure 8-1).		

- 1. SendCommand (MTAP\_SW\_MTAP).
- 2. SendCommand (MTAP COMMAND).
- 3. statusVal = XferData (MCHP\_STATUS).
- 4. If CPS (statusVal<7>) is not '1', the device must be erased first.
- 5. SendCommand (MTAP\_SW\_ETAP).
- 6. SendCommand (ETAP\_EJTAGBOOT).
- 7. Set MCLR high.

# 10.2 2-wire Interface

The following steps are required to enter Serial Execution mode:

- 1. SendCommand (MTAP\_SW\_MTAP).
- 2. SendCommand (MTAP COMMAND).
- 3. statusVal = XferData (MCHP STATUS).
- 4. If CPS (statusVal<7>) is not '1', the device must be erased first.
- 5. XferData (MCHP\_ASSERT\_RST).
- 6. SendCommand (MTAP SW ETAP).
- 7. SendCommand (ETAP\_EJTAGBOOT).
- 8. SendCommand (MTAP\_SW\_MTAP).
- 9. SendCommand (MTAP\_COMMAND).
- 10. XferData (MCHP\_DE\_ASSERT\_RST).
- 11. XferData (MCHP\_FLASH\_ENABLE) This step is not required for PIC32MZ EC family devices.
- 12. SendCommand (MTAP\_SW\_ETAP).

# 11.0 DOWNLOADING THE PROGRAMMING EXECUTIVE (PE)

The PE resides in RAM memory and is executed by the CPU to program the device. The PE provides the mechanism for the programmer to program and verify PIC32 devices using a simple command set and communication protocol. There are several basic functions provided by the PE:

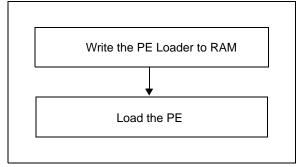
- · Read memory
- · Erase memory
- Program memory
- Blank check
- Read executive firmware revision
- Get the Cyclic Redundancy Check (CRC) of Flash memory locations

The PE performs the low-level tasks required for programming and verifying a device. This allows the programmer to program the device by issuing the appropriate commands and data. A detailed description for each command is provided in Section 16.2 "The PE Command Set".

The PE uses the device's data RAM for variable storage and program execution. After the PE has run, no assumptions should be made about the contents of data RAM.

After the PE is loaded into the data RAM, the PIC32 family can be programmed using the command set shown in Table 16-1.

FIGURE 11-1: DOWNLOADING THE PE



Loading the PE in the memory is a two step process:

- 1. Load the PE loader in the data RAM. (The PE loader loads the PE binary file in the proper location of the data RAM, and when done, jumps to the programming exec and starts executing it.)
- 2. Feed the PE binary to the PE loader.

Table 11-1 lists the steps that are required to download the PE.

# TABLE 11-1: DOWNLOAD THE

P	PE			
Operation	Operand			
Step 1: Initialize BI	MXCON to 0x1F0040. The instruction			
sequence	executed by the PIC32 core is:			
lui a0,0xbf88				
	/* address of BMXCON */			
lui al,0x1f				
ori a1,a1,0x40 sw a1,0(a0)	/* \$al has 0x1f0040 */ /* BMXCON initialized */			
XferInstruction				
XferInstruction				
XferInstruction	0x3c05001f			
XferInstruction	0x34a50040			
XferInstruction	0xac850000			
	MXDKPBA to 0x800. The instruction			
	executed by the PIC32 core is:			
li a1,0x800				
sw a1,16(a0)				
XferInstruction	0x34050800			
XferInstruction	0xac850010			
	MXDUDBA and BMXDUPBA to the			
value of BN	MXDRMSZ. The instruction sequence			
	y the PIC32 core is:			
lw a1,64(a0)	/* load BMXDMSZ */			
sw a1,32(a0) sw a1,48(a0)				
XferInstruction	0x8C850040			
XferInstruction				
XferInstruction				
	32 RAM address for PE. The instruc-			
•	nce executed by the PIC32 core is:			
lui a0,0xa000				
ori a0,a0,0x800				
XferInstruction	0x3c04a000			
XferInstruction	0x34840800			
	E_Loader. Repeat this step (Step 5)			
	tire PE_Loader is loaded in the PIC32			
	the operands field, " <pe_loader presents the MSbs 31 through 16 of the</pe_loader 			
	op codes shown in Table 11-2. Like-			
	loader lo++>" represents the LSbs			
	0 of the PE loader op codes shown in			
	The "++" sign indicates that when			
	ations are performed in succession, ord is to be transferred from the list of			
	f the LPE Loader shown in Table 11-2.			
	tion sequence executed by the PIC32			
core is:	· · ·			
	loader hi++>			
	PE_loader lo++>			
sw a2,0(a0)				
addiu a0,a0,4				
XferInstruction	(0x3c06 <pe_loader hi++=""> )</pe_loader>			
XferInstruction	(0x34c6 <pe_loader lo++=""> )</pe_loader>			
XferInstruction 0xac860000				
XferInstruction 0x24840004				

# TABLE 11-1: DOWNLOAD THE PE (CONTINUED)

-	PE (CONTINUED)			
Оре	ration	Operand		
Step 6:	6: Jump to the PE_Loader. The instruction sequence executed by the PIC32 core is:			
lui ori jr nop	t9,0xa000 t9,t9,0x800 t9			
XferIns	struction	0x3c19a000		
XferIns	struction	0x37390800		
XferIns	struction	0x03200008		
XferIns	struction	0x0000000		
PE is loaded into the PIC32 memory. In this step, you are given an Intel <sup>®</sup> Hex format file of the PE that you will parse and transfer a number of 32-bit words at a time to the PIC32 memory (refer to <b>Appendix B: "Hex File Format</b> "). The instruction sequence executed by the PIC32 is shown in the "Instruction" column of Table 11-2: PE Loader Op Codes.				
SendCommand		ETAP_FASTDATA		
XferFastData		PE_ADDRESS (Address of PE program block from PE Hex file)		
XferFastData		PE_SIZE (Number of 32-bit words of the program block from PE Hex file)		
XferFastData		PE software op code from PE Hex file (PE Instructions)		
Step 8:	instructs the loaded into	e PE. Magic number (0xDEAD0000) e PE_Loader that the PE is completely the memory. When the PE_Loader agic number, it jumps to the PE.		
XferFas	stData	0x0000000		
XferFas	stData	0xDEAD0000		

# TABLE 11-2: PE LOADER OP CODES

Op code	Instruction
0x3c07dead	lui a3, 0xdead
0x3c06ff20	lui a2, 0xff20
0x3c05ff20	lui al, 0xff20
	herel:
0x8cc40000	lw a0, 0 (a2)
0x8cc30000	lw v1, 0 (a2)
0x1067000b	beq v1, a3, <here3></here3>
0x00000000	nop
0x1060fffb	beqz v1, <here1></here1>
0x00000000	nop
	here2:
0x8ca20000	lw v0, 0 (a1)
0x2463ffff	addiu v1, v1, -1
0xac820000	sw v0, 0 (a0)
0x24840004	addiu a0, a0, 4
0x1460fffb	bnez v1, <here2></here2>
0x00000000	nop
0x1000fff3	b <here1></here1>
0x00000000	nop
	here3:
0x3c02a000	lui v0, 0xa000
0x34420900	ori v0, v0, 0x900
0x00400008	jr v0
0x00000000	nop

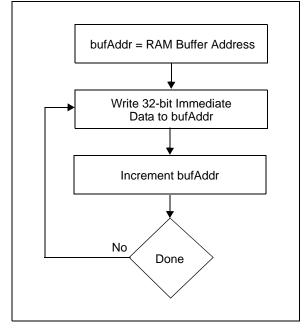
# 12.0 DOWNLOADING A DATA BLOCK

To program a block of data to the PIC32 device, it must first be loaded into SRAM.

# 12.1 Without the PE

To program a block of memory without the use of the PE, the block of data must first be written to RAM. This method requires the programmer to transfer the actual machine instructions with embedded (immediate) data for writing the block of data to the devices internal RAM memory.

FIGURE 12-1: DOWNLOADING DATA WITHOUT THE PE



The following steps are required to download a block of data:

- 1. XferInstruction (op code).
- 2. Repeat Step 1 until the last instruction is transferred to CPU.

#### TABLE 12-1: DOWNLOAD DATA OP CODES

Op code	Instruction
Step 1: Initialize	SRAM Base Address to 0xA0000000.
3c10a000	lui \$s0, 0xA000;
-	entire row of data to be programmed em SRAM.
3c08 <data> 3508<data> ae08<offset></offset></data></data>	<pre>lui \$t0, <data(31:16)>; ori \$t0, <data(15:0)>; sw \$t0, <offset>(\$s0);</offset></data(15:0)></data(31:16)></pre>
Step 3: Repeat S loaded.	tep 2 until one row of data has been

# 12.2 With the PE

When using the PE the steps in Section 12.0 "Downloading a Data Block" and Section 13.0 "Initiating a Flash Row Write" are handled in two single commands: ROW PROGRAM and PROGRAM.

The ROW\_PROGRAM command programs a single row of Flash data, while the PROGRAM command programs multiple rows of Flash data. Both of these commands are documented in Section 16.0 "The Programming Executive".

# 13.0 INITIATING A FLASH ROW WRITE

Note: Certain PIC32 devices have available ECC memory. When the ECC feature is used, Flash memory must be programmed in groups of four 32-bit words using four, 32-bit word alignment. If ECC is dynamically used, the programming method determines when the feature is used. ECC is not enabled for words programmed with the single word programming command. ECC is enabled for words programmed in groups of four, either with the quad word or row programming commands. Failure to adhere to these methods can result in ECC DED errors during run-time. See the specific device data sheet for details regarding ECC use and configuration.

Once a row of data has been downloaded into the device's SRAM, the programming sequence must be initiated to write the block of data to Flash memory.

See Table 13-1 for the op code and instructions for initiating a Flash row write.

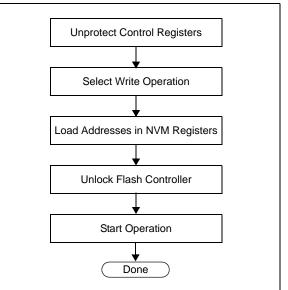
# 13.1 With the PE

When using the PE, the data is immediately written to the Flash memory from the SRAM. No further action is required.

# 13.2 Without the PE

Flash memory write operations are controlled by the NVMCON register. Programming is performed by setting NVMCON to select the type of write operation and initiating the programming sequence by setting the WR control bit (NVMCON<15>).

FIGURE 13-1:	INITIATING FLASH WRITE
	WITHOUT THE PE



The following steps are required to initiate a Flash write:

- 1. XferInstruction (op code).
- 2. Repeat Step 1 until the last instruction is transferred to the CPU.

#### TABLE 13-1: INITIATE FLASH ROW WRITE OP CODES FOR PIC32 DEVICES

Op Code		Instruction	
Step 1:	a1, a2, a NVMOP respectiv	<b>2 devices:</b> Initialize constants. Registers and a3 are set for WREN = 1 or <3:0> = 0011, WR = 1 and WREN = 1, vely. Registers s1 and s2 are set for the ata values and S0 is initialized to '0'.	
3405400	3	ori a1,\$0,0x4003	
3406800		ori a2,\$0,0x8000	
3407400		ori a3,\$0,0x4000	
3cllaa9		lui s1,0xaa99	
3631665		ori s1,s1,0x6655	
3c12556 365299a		lui s2,0x5566	
3c10000		ori s2,s2,0x99aa lui s0,0x0000	
Step 2:		X devices only: Set register a0 to the dress of the NVM register (0xBF80_F400).	
3c04bf8	0	lui a0,0xbf80	
3484f4C	0	ori a0,a0,0xf400	
3c04bf8 3484060	write pro	s3 is set for the value used to disable tection in NVMBPB. lui a0,0xbf80 ori a0,a0,0x0600	
3415808	0	ori s3,\$0,0x8080	
Step 3:		<b>Z EC devices only:</b> Unlock and disable sh write protection.	
AC91001	0	sw s1,16(a0)	
AC92001	0	sw s2,16(a0)	
AC95009		sw s3,144(a0)	
0000000	0	nop	
Step 4:		2 devices: Set the NVMADDR register address of the Flash row to be med.	
3c08 <ae< td=""><td>DR&gt;</td><td><pre>lui t0,<flash_row_addr(31:16)></flash_row_addr(31:16)></pre></td></ae<>	DR>	<pre>lui t0,<flash_row_addr(31:16)></flash_row_addr(31:16)></pre>	
3508 <ae< td=""><td>DR&gt;</td><td><pre>ori t0,t0,<flash_row_addr(15:0)></flash_row_addr(15:0)></pre></td></ae<>	DR>	<pre>ori t0,t0,<flash_row_addr(15:0)></flash_row_addr(15:0)></pre>	
ac88002	0	sw t0,32(a0)	
	PIC32M	X devices only: Set the NVMSRCADDR with the physical source SRAM address	
ac88002	PIC32M register (offset is	X devices only: Set the NVMSRCADDR with the physical source SRAM address	

#### TABLE 13-1: INITIATE FLASH ROW WRITE OP CODES FOR PIC32 DEVICES (CONTINUED)

	DEVICES (CONTINUED)			
Op Co	de	Instruction		
Step 5:	NVMSR	<b>Z EC devices only:</b> Set the CADDR register with the physical source address (offset is 112).		
3610 <ai< td=""><td></td><td>ori s0,s0,<ram addr(15:0)=""></ram></td></ai<>		ori s0,s0, <ram addr(15:0)=""></ram>		
ac90004	10			
Step 6:		<b>32 devices:</b> Set up the NVMCON register operation.		
ac85000	00	sw a1,0(a0) delay (6 µs)		
Step 7:		X devices only: Poll the LVDSTAT		
	register.			
0 0 0 0 0 0 0		here1:		
80088000		lw t0,0(a0)		
3108080 1500fff		andi t0,t0,0x0800		
0000000		bne t0,\$0,here1 nop		
		<b>32 devices:</b> Unlock the NVMCON register		
Step 8:		t the write operation.		
ac91001	0	sw s1,16(a0)		
ac92001	0	sw s2,16(a0)		
ac86000	)8	sw a2,8(a0)		
Step 9:		<b>32 devices:</b> Loop until the WR bit ON<15>) is clear.		
		here2:		
8c88000	0	lw t0,0(a0)		
0106402	24	and t0,t0,a2		
1500fff		bne t0,\$0,here2		
0000000		nop		
Step 10:	seeing a writing t inserting example	<b>32 devices:</b> Wait at least 500 ns after a '0' in the WR bit (NVMCON<15>) before o any of the NVM registers. This requires g a NOP in the execution. The following e assumes that the core is executing at		
	8 MHz; 500 ns.	therefore, four NOP instructions equate to		
0000000	0	nop		
0000000		nop		
0000000	0	nop		
0000000	00	nop		
Step 11:		<b>32 devices:</b> Clear the WREN bit ONM<14>).		
ac87000	)4	sw a3,4(a0)		
Step 12:	(NVMC) sequence	<b>32 devices:</b> Check the WRERR bit DN<13>) to ensure that the program ce has completed successfully. If an error jump to the error processing routine.		
8c88000 3008200 1500 <er 0000000</er 	)0 R_PROC>	<pre>lw t0,0(a0) andi t0,zero,0x2000 bne t0, \$0, <err_proc_offset> nerperoc_offset&gt;</err_proc_offset></pre>		
		nop		

# 14.0 VERIFY DEVICE MEMORY

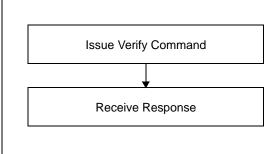
The verify step involves reading back the code memory space and comparing it against the copy held in the programmer's buffer. The Configuration registers are verified with the rest of the code.

Note:	Because the Configuration registers include the device code protection bit, code memory should be verified immedi- ately after writing (if code protection is enabled). This is because the device will not be readable or verifiable if a device Reset occurs after the code-protect bit
	Reset occurs after the code-protect bit has been cleared.

# 14.1 Verifying Memory with the PE

Memory verify is performed using the  ${\tt GET\_CRC}$  command, as shown in Table 16-2.





The following steps are required to verify memory using the PE:

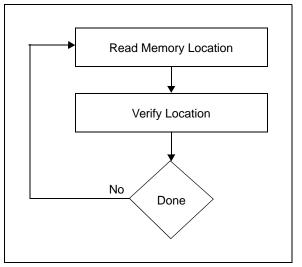
- 1. XferFastData (GET\_CRC).
- 2. XferFastData (start\_Address).
- 3. XferFastData (length).
- 4. valCkSum = XferFastData (32'h0x00).

Verify that valCkSum matches the checksum of the copy held in the programmer's buffer.

# 14.2 Verifying Memory without the PE

Reading from Flash memory is performed by executing a series of read accesses from the Fastdata register. Table 19-4 shows the EJTAG programming details, including the address and op code data for performing processor access operations.

#### FIGURE 14-2: VERIFYING MEMORY WITHOUT THE PE



The following steps are required to verify memory:

- 1. XferInstruction (op code).
- 2. Repeat Step 1 until the last instruction is transferred to the CPU.
- 3. Verify that valRead matches the copy held in the programmer's buffer.
- 4. Repeat Steps 1-3 for each memory location.

# TABLE 14-1: VERIFY DEVICE OP CODES

Op code	Instruction		
Step 1: Initia	Step 1: Initialize some constants.		
3c13ff20	lui \$s3, 0xFF20		
Step 2: Read memory Location.			
3c08 <addr> 3508<addr></addr></addr>	<pre>lui \$t0,<flash_word_addr(31:16)> ori \$t0,<flash_word_addr(15:0)></flash_word_addr(15:0)></flash_word_addr(31:16)></pre>		
Step 3: Write to Fastdata location.			
8d090000 ae690000	lw \$t1, 0(\$t0) sw \$t1, 0(\$s3)		
Step 4: Read data from Fastdata register 0xFF200000.			
Step 5: Repearer	eat Steps 2-4 until all configuration locations ead.		

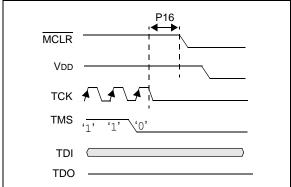
# 15.0 EXITING PROGRAMMING MODE

Once a device has been properly programmed, the device must be taken out of Programming mode to start proper execution of its new program memory contents.

# 15.1 4-wire Interface

Exiting Programming mode is done by removing VIH from MCLR, as illustrated in Figure 15-1. The only requirement for exit is that an interval, P16, should elapse between the last clock and program signals before removing VIH.

FIGURE 15-1: 4-WIRE EXIT PROGRAMMING MODE



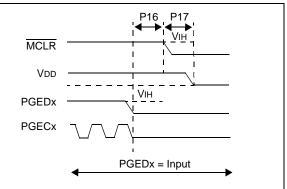
The following steps are required to exit Programming mode:

- 1. SetMode (5'b11111).
- 2. Assert MCLR.
- 3. Remove power (if the device is powered).

# 15.2 2-wire Interface

Exiting Programming mode is done by removing VIH from MCLR, as illustrated in Figure 15-2. The only requirement for exit is that an interval, P16, should elapse between the last clock and program signals on PGECx and PGEDx before removing VIH.

FIGURE 15-2: 2-WIRE EXIT PROGRAMMING MODE



The following list provides the actual steps required to exit Programming mode:

- 1. SetMode (5'b11111).
- 2. Assert MCLR.
- 3. Issue a clock pulse on PGECx.
- 4. Remove power (if the device is powered).

# 16.0 THE PROGRAMMING EXECUTIVE

**Note:** The Programming Executive (PE) is included with your installation of MPLAB<sup>®</sup> IDE. To download the appropriate PE file for your device, please visit the related product page on the Microchip web site.

# **16.1 PE Communication**

The programmer and the PE have a master-slave relationship, where the programmer is the master programming device and the PE is the slave.

All communication is initiated by the programmer in the form of a command. The PE is able to receive only one command at a time. Correspondingly, after receiving and processing a command, the PE sends a single response to the programmer.

# 16.1.1 2-WIRE ICSP EJTAG RATE

In Enhanced ICSP mode, the PIC32 family devices operate from the internal Fast RC oscillator, which has a nominal frequency of 8 MHz.

# 16.1.2 COMMUNICATION OVERVIEW

The programmer and the PE communicate using the EJTAG Address, Data and Fastdata registers. In particular, the programmer transfers the command and data to the PE using the Fastdata register. The programmer receives a response from the PE using the Address and Data registers. The pseudo operation of receiving a response is shown in the GetPEResponse pseudo operation below:

#### Format:

response = GetPEResponse()

#### Purpose:

Enables the programmer to receive the 32-bit response value from the PE.

#### EXAMPLE 16-1: GetPEResponse EXAMPLE

```
WORD GetPEResponse()
        WORD response;
// Wait until CPU is ready
SendCommand(ETAP CONTROL);
// Check if Proc. Access bit (bit 18) is set
do {
      controlVal=XferData(32'h0x0004C000 );
} while( PrAcc(contorlVal<18>) is not '1' );
// Select Data Register
SendCommand (ETAP DATA);
// Receive Response
response = XferData(0);
// Tell CPU to execute instruction
SendCommand (ETAP CONTROL);
XferData(32'h0x0000C000);
// return 32-bit response
return response;
```

The typical communication sequence between the programmer and the PE is shown in Table 16-1.

The sequence begins when the programmer sends the command and optional additional data to the PE, and the PE carries out the command.

When the PE has finished executing the command, it sends the response back to the programmer.

The response may contain more than one response. For example, if the programmer sent a READ command, the response will contain the data read.

TABLE 16-1:	COMMUNICATION	
	SEQUENCE FOR THE PE	

Operation		Operand
Step 1:	Send command programmer to	l and optional data from the PE.
XferFastData		(Command   data len)
XferFastData		optional data
<b>Step 2:</b> Programmer reads the response from the PE.		
GetPERe	esponse	response
GetPERe	esponse	response

# 16.2 The PE Command Set

The PE command set is shown in Table 16-2. This table contains the op code, mnemonic, and short description for each command. Functional details on each command are provided in Section 16.2.3 "ROW\_PROGRAM Command" through Section 16.2.14 "CHANGE\_CFG Command".

The PE sends a response to the programmer for each command that it receives. The response indicates if the command was processed correctly. It includes any required response data or error data.

#### 16.2.1 COMMAND FORMAT

All PE commands have a general format consisting of a 32-bit header and any required data for the command (see Figure 16-1). The 32-bit header consists of a 16-bit Op code field, which is used to identify the command, and a 16-bit command Operand field. Use of the Operand field varies by command.

**Note:** Some commands have no Operand information, however, the Operand field must be sent and the programming executive will ignore the data.

#### FIGURE 16-1: COMMAND FORMAT

31		16
	Op code	
15		0
	Operand (optional)	
31		16
	Command Data High (if required)	
15		0
	Command Data Low (if required)	

The command in the Op code field must match one of the commands in the command set that is listed in Table 16-2. Any command received that does not match a command the list returns a NACK response, as shown in Table 16-3.

The PE uses the command Operand field to determine the number of bytes to read from or to write to. If the value of this field is incorrect, the command is not be properly received by the PE.

Mnemonic	Description
ROW_PROGRAM <sup>(1)</sup>	Program one row of Flash memory at the specified address.
READ	Read N 32-bit words of memory starting from the specified address (N < 65,536).
PROGRAM	Program Flash memory starting at the specified address.
WORD_PROGRAM(3)	Program one word of Flash memory at the specified address.
CHIP_ERASE	Chip Erase of entire chip.
PAGE_ERASE	Erase pages of code memory from the specified address.
BLANK_CHECK	Blank Check code.
EXEC_VERSION	Read the PE software version.
GET_CRC	Get the CRC of Flash memory.
PROGRAM_CLUSTER	Programs the specified number of bytes to the specified address.
GET_DEVICEID	Returns the hardware ID of the device.
CHANGE_CFG(2)	Used by the probe to set various configuration settings for the PE.
GET_CHECKSUM	Get the checksum of Flash memory.
QUAD_WORD_PGRM(4)	Program four words of Flash memory at the specified address.
	ROW_PROGRAM <sup>(1)</sup> READ PROGRAM WORD_PROGRAM <sup>(3)</sup> CHIP_ERASE PAGE_ERASE BLANK_CHECK EXEC_VERSION GET_CRC PROGRAM_CLUSTER GET_DEVICEID CHANGE_CFG <sup>(2)</sup>

#### TABLE 16-2: PE COMMAND SET

Note 1: Refer to Table 5-1 for the row size for each device.

- 2: This command is not available in PIC32MX1XX/2XX devices.
- 3: On the PIC32MZ EC family devices, which incorporate ECC, the WORD\_PROGRAM command will not generate the ECC parity bits. Reading a location programmed with the WORD\_PROGRAM command with ECC enabled will cause a DED fault.
- 4: This command is available on PIC32MZ EC family devices only.

#### 16.2.2 RESPONSE FORMAT

The PE response set is shown in Table 16-3. All PE responses have a general format consisting of a 32-bit header and any required data for the response (see Figure 16-2).

FIGURE 16-2:	<b>RESPONSE FORMAT</b>

31		16
	Last Command	
15		0
	Response Code	
31		16
	Data_High_1	
15		0
	Data_Low_1	
31		16
	Data_High_N	
15		0
	Data_Low_N	

#### 16.2.2.1 Last\_Cmd Field

Last\_Cmd is a 16-bit field in the first word of the response and indicates the command that the PE processed. It can be used to verify that the PE correctly received the command that the programmer transmitted.

#### 16.2.2.2 Response Code

The response code indicates whether the last command succeeded or failed, or if the command is a value that is not recognized. The response code values are shown in Table 16-3.

#### TABLE 16-3: RESPONSE VALUES

Op code	Mnemonic	Description
0x0	PASS	Command successfully processed
0x2	FAIL	Command unsuccessfully processed
0x3	NACK	Command not known

#### 16.2.2.3 Optional Data

The response header may be followed by optional data in case of certain commands such as read. The number of 32-bit words of optional data varies depending on the last command operation and its parameters.

#### 16.2.3 ROW PROGRAM COMMAND

The ROW\_PROGRAM command instructs the PE to program a row of data at a specified address.

The data to be programmed to memory, located in command words Data\_1 through Data\_N, must be arranged using the packed instruction word format shown in Table 16-4 (this command expects an entire row of data).

FIGURE 16-3: ROW_PROGRAM COMMAND		MMAND
31		16
	Op code	
15		0
	Operand	
31		16
	Addr_High	
15		0
	Addr_Low	
31		16
	Data_High_1	
15		0
	Data_Low_1	
31		16
	Data_High_N	
15		0
	Data_Low_N	

# TABLE 16-4: ROW\_PROGRAM FORMAT

Field	Description
Op code	0x0
Operand	Not used
Addr_High	High 16 bits of 32-bit destination address
Addr_Low	Low 16 bits of 32-bit destination address
Data_High_1	High 16 bits data word 1
Data_Low_1	Low 16 bits data word 1
Data_High_N	High 16 bits data word 2 through N
Data_Low_N	Low 16 bits data word 2 through N

#### Expected Response (1 word):

FIGURE 16-4: ROW_PROGRAM RESPONS	
31	16
	Last Command
15	0
	Response Code

# 16.2.4 READ COMMAND

The READ command instructs the PE to read from memory the number of 32-bit words specified in the Operand field starting from the 32-bit address specified by the Addr\_Low and Addr\_High fields. This command can be used to read Flash memory, as well as Configuration Words. All data returned in response to this command uses the packed data format that is shown in Table 16-5.

FIGURE 16-5: READ COMMAND

31		16
	Op code	
15		0
	Operand	
31		16
	Addr_High	
15		0
	Addr_Low	

# TABLE 16-5: READ FORMAT

Field	Description
Op code	0x1
Operand	N number of 32-bit words to read (maximum of 65,535)
Addr_Low	Low 16 bits of 32-bit source address
Addr_High	High 16 bits of 32-bit source address

**Expected Response:** 

#### FIGURE 16-6: READ RESPONSE

31	16
	Last Command
15	0
	Response Code
31	16
	Data_High_1
15	0
	Data_Low_1
31	16
	Data_High_N
15	0
	Data_Low_N
Note:	Reading unimplemented memory will cause the PE to reset. Please ensure that only memory locations present on a particular device are accessed.

#### 16.2.5 PROGRAM COMMAND

The PROGRAM command instructs the PE to program Flash memory, including Configuration Words, starting from the 32-bit address specified in the Addr\_Low and Addr\_High fields. A 32-bit length field specifies the number of bytes to program.

The address must be aligned to a Flash row size boundary and the length must be a multiple of a Flash row size. Flash row sizes are either 32 words (128 bytes) or 128 words (512 bytes). Please refer to Table 5-1.

FIGURE 16-7: PROGRAM COMMAND

Op code           15         0           Operand         31           31         16           Addr_High         15           15         0           Addr_Low         31           31         16           Length_High         15           15         0           Length_Low         31           31         16           Data_High_1         16           Data_Low_1         31           15         0           Data_Low_1         16           Data_Low_N         0	31		16
Operand           31         16           Addr_High         0           15         0           Addr_Low         0           S1         16           Length_High         16           Length_High         16           Length_Low         0           S1         16           Data_High_1         16           Data_Low_1         0           S1         0           Data_Low_1         16           Data_High_N         16           Data_High_N         0		Op code	
31       16         Addr_High       0         15       0         31       16         Length_High       15         15       0         Length_Low       31         31       16         Data_High_1       16         Data_Low_1       0         31       16         Data_Low_1       0         15       0         15       0         15       0         15       0         15       0         15       0	15		0
Addr_High         15       0         Addr_Low         31       16         Length_High         15       0         Length_Low         31       16         Data_High_1         15       0         Data_High_1         15       0         Data_Low_1         31       16         Data_High_N         15       0         15       0		Operand	
15       0         Addr_Low       31         31       16         Length_High       0         15       0         Length_Low       31         31       16         Data_High_1       16         15       0         I       Data_Low_1         31       16         Data_Low_1       16         I       Data_High_N         15       0	31		16
Addr_Low         31       16         Length_High         15       0         Length_Low         31       16         Data_High_1         15       0         Data_Low_1         31       16         Data_Low_1         31       16         15       0         15       0         15       0         15       0		Addr_High	
31       16         Length_High       15         15       0         Length_Low       31         31       16         Data_High_1       16         15       0         15       0         Data_Low_1       31         31       16         Data_High_N       15         0       0	15		0
Length_High           15         0           Length_Low         31           31         16           Data_High_1         15           15         0           Data_Low_1         31           31         16           Data_Low_1         16           15         0           15         0           15         0		Addr_Low	
15       0         Length_Low       31         31       16         Data_High_1       15         15       0         31       16         Data_Low_1       31         31       16         Data_High_N       15         0       0	31		16
Length_Low           31         16           Data_High_1         15           15         0           31         16           Data_Low_1         31           31         16           Data_High_N         15           0         0		Length_High	
31     16       Data_High_1     15       15     0       Data_Low_1       31     16       Data_High_N       15     0	15		0
Data_High_1           15         0           Data_Low_1         31           31         16           Data_High_N         0		Length_Low	
15         0           Data_Low_1         31           31         16           Data_High_N         15	31		16
Data_Low_1           31         16           Data_High_N         15		Data_High_1	
31         16           Data_High_N         15	15		0
Data_High_N 15 0		Data_Low_1	
15 0	31		16
		Data_High_N	
Data_Low_N	15		0
		Data_Low_N	

#### **TABLE 16-6:PROGRAM FORMAT**

Field	Description
Op code	0x2
Operand	Not used
Addr_Low	Low 16 bits of 32-bit destination address
Addr_High	High 16 bits of 32-bit destination address
Length_Low	Low 16 bits of Length
Length_High	High 16 bits Length
Data_Low_N	Low 16 bits data word 2 through N
Data_High_N	High 16 bits data word 2 through N

There are three programming scenarios:

- 1. The length of the data to be programmed is the size of a single flash row.
- 2. The length of the data to be programmed is the size of two flash rows.
- 3. The length of the data to be programmed is larger than the size of two flash rows.

When the data length is equal to 512 bytes, the PE receives the 512-byte block of data from the probe and immediately sends the response for this command back to the probe.

The PE will respond for each row of data that it receives. If the data length of the command is equal to a single row, a single PE response is generated. If the data length is equal to two rows, the PE waits to receive both rows of data, and then sends back-toback responses for each data row. If the data length is greater than two rows of data, the PE will send the response for the first row after receiving the first two rows of data. Subsequent responses are sent after receiving subsequent data row packets. The responses will lag the data by one row. When the last row of data is received the PE will respond with backto-back responses for the second-to-last data row followed by the last row.

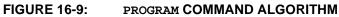
If the PE encounters an error in programming any of the blocks, it sends a failure status to the probe and aborts the PROGRAM command. On receiving the failure status, the probe must stop sending data. The PE will not process any other data for this command from the probe. The process is illustrated in Figure 16-9.

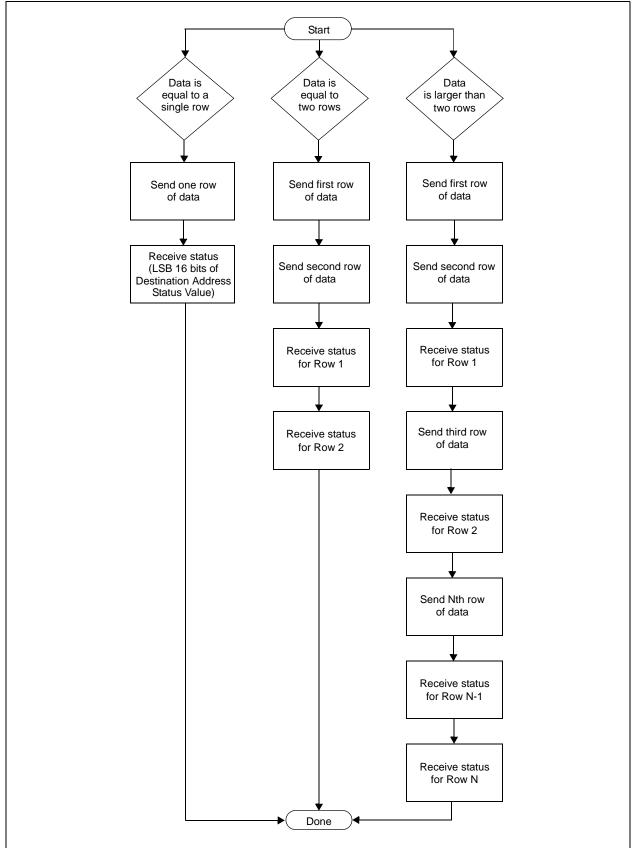
Note:	If the PROGRAM command fails, the
	programmer should read the failing row
	using the READ command from the Flash
	memory. Next, the programmer should
	compare the row received from Flash
	memory to its local copy, word-by-word, to
	determine the address where Flash
	programming fails.

The response for this command is a little different than the response for other commands. The 16 MSbs of the response contain the 16 LSbs of the destination address, where the last block is programmed. This helps the probe and the PE maintain proper synchronization of sending, and receiving, data and responses.

#### Expected Response (1 word):

FIGURE 16-8:	PROGRAM <b>RESPONSE</b>
31	16
LSB 16 bits of the destination address of last block	
15	0
Response Code	





#### 16.2.6 WORD\_PROGRAM COMMAND

The <code>WORD\_PROGRAM</code> command instructs the PE to program a 32-bit word of data at the specified address.

## FIGURE 16-10: WORD\_PROGRAM COMMAND

	• • • • • • • • • • •	
31		16
	Op code	
15		0
	Operand	
31		16
	Addr_High	
15		0
	Addr_Low	
31		16
	Data_High	
15		0
	Data_Low	

#### TABLE 16-7: WORD\_PROGRAM FORMAT

Field	Description
Op code	0x3
Operand	Not used
Addr_High	High 16 bits of 32-bit destination address
Addr_Low	Low 16 bits of 32-bit destination address
Data_High	High 16 bits data word
Data_Low	Low 16 bits data word

#### Expected Response (1 word):

FIGURE 16-11:	word_program RESPONSE	
31		16
	Last Command	
15		0
	Response Code	

#### 16.2.7 CHIP ERASE COMMAND

The CHIP\_ERASE command erases the entire chip, including the configuration block.

After the erase is performed, the entire Flash memory contains 0xFFFFFFF.

#### FIGURE 16-12: CHIP\_ERASE COMMAND

31		16
	Op code	
15		0
	Operand	

#### TABLE 16-8: CHIP ERASE FORMAT

Field	Description
Op code	0x4
Operand	Not used
Addr_Low	Low 16 bits of 32-bit destination address
Addr_High	High 16 bits of 32-bit destination address

#### Expected Response (1 word):

#### FIGURE 16-13: CHIP\_ERASE RESPONSE

31		16
	Last Command	
15		0
	Response Code	

#### 16.2.8 PAGE\_ERASE COMMAND

The PAGE\_ERASE command erases the specified number of pages of code memory from the specified base address. Depending on the device, the specified base address must be a multiple of 0x400 or 0x100.

After the erase is performed, all targeted words of code memory contain 0xFFFFFFF.

FIGURE 16-14: PAGE\_ERASE COMMAND

31		16
	Op code	
15		0
	Operand	
31		16
	Addr_High	
15		0

#### TABLE 16-9: PAGE ERASE FORMAT

Field	Description
Op code	0x5
Operand	Number of pages to erase
Addr_Low	Low 16 bits of 32-bit destination address
Addr_High	High 16 bits of 32-bit destination address

#### Expected Response (1 word):

#### FIGURE 16-15: PAGE\_ERASE RESPONSE

31		16
	Last Command	
15		0
	Response Code	

#### 16.2.9 BLANK CHECK COMMAND

The BLANK\_CHECK command queries the PE to determine whether the contents of code memory and code-protect Configuration bits (GCP and GWRP) are blank (contains all '1's).

### FIGURE 16-16: BLANK\_CHECK COMMAND

31		16
	Op code	
15		0
	Operand	
31		16
	Addr_High	
15		0
	Addr_Low	
31		16
	Length_High	
15		0
	Length_Low	

#### TABLE 16-10: BLANK CHECK FORMAT

Field	Description
Op code	0x6
Operand	Not used
Address	Address where to start the Blank Check
Length	Number of program memory locations to check in terms of bytes

#### Expected Response (1 word for blank device):

FIGURE 16-17:	BLANK_CHECK RESPONSE
31	16
	Last Command
15	0
	Response Code

#### 16.2.10 EXEC VERSION COMMAND

 $\tt EXEC\_VERSION$  queries for the version of the PE software stored in RAM.

## FIGURE 16-18: EXEC\_VERSION COMMAND

31		16
	Op code	
15		0
	Operand	

#### TABLE 16-11: EXEC\_VERSION FORMAT

Field	Description
Op code	0x7
Operand	Not used

#### Expected Response (1 word):

#### FIGURE 16-19: EXEC\_VERSION RESPONSE

31		16
	Last Command	
15		0
	Version Number	

#### 16.2.11 GET CRC COMMAND

GET\_CRC calculates the CRC of the buffer from the specified address to the specified length, using the table look-up method. The CRC details are as follows:

- CRC-CCITT, 16-bit
- Polynomial: X^16+X^12+X^5+1, hex 0x00011021
- Seed: 0xFFFF
- · Most Significant Byte (MSB) shifted in first
  - **Note 1:** In the response, only the CRC Least Significant 16 bits are valid.
    - 2: The PE will automatically determine if the hardware CRC is available and use it by default. The hardware CRC is not used on PIC32MX1XX/2XX devices.

FIGURE 16-20:	GET_CRC COMMAND

31		16
	Op code	
15		0
	Operand	
31		16
	Addr_High	
15		0
	Addr_Low	
31		16
	Length_High	
15		0
	Length_Low	

#### TABLE 16-12: GET\_CRC FORMAT

Field	Description
Op code	0x8
Operand	Not used
Address	Address where to start calculating the CRC
Length	Length of buffer on which to calculate the CRC, in number of bytes

#### Expected Response (2 words):

FIGURE 16-21:	GET_CRC RESPONSE	
31		16
	Last Command	
15		0
	Response Code	
31		16
	CRC_High	
15		0
	CRC_Low	

#### 16.2.12 PROGRAM\_CLUSTER COMMAND

PROGRAM\_CLUSTER programs the specified number of bytes to the specified address. The address must be 32-bit aligned, and the number of bytes must be a multiple of a 32-bit word.

## FIGURE 16-22: PROGRAM\_CLUSTER COMMAND

31	16
Op code	
15	0
Operand	
31	16
Addr_High	
15	0
Addr_Low	
31	16
Length_High	
15	0
Length_Low	

#### TABLE 16-13: PROGRAM CLUSTER FORMAT

Field	Description
Op code	0x9
Operand	Not used
Address	Start address for programming
Length	Length of area to program in number of bytes

Note: If the PROGRAM\_CLUSTER command fails, the programmer should read the failing row using the READ command from the Flash memory. Next, the programmer should compare the row received from Flash memory to its local copy word-by-word to determine the address where Flash programming fails.

Expected Response (1 word):

#### FIGURE 16-23: PROGRAM\_CLUSTER RESPONSE

31		16
	Last Command	
15		0
	Response Code	

#### 16.2.13 GET DEVICEID COMMAND

The  $\ensuremath{\texttt{GET\_DEVICEID}}$  command returns the hardware ID of the device.

FIGURE 16-24:	GET_DEVICEID COMMAND	
31		16
	Op code	
15		0
	Operand	

#### TABLE 16-14: GET\_DEVICEID FORMAT

Field	Description
Op code	0xA
Operand	Not used

#### Expected Response (1 word):

FIGURE 16-25:	GET_DEVICEID RESPONSE	
31		16
	Last Command	
15		0
	Device ID	

#### 16.2.14 CHANGE\_CFG COMMAND

CHANGE\_CFG is used by the probe to set various configuration settings for the PE. Currently, the single configuration setting determines which of the following calculation methods the PE should use:

- Software CRC calculation method
- Hardware calculation method

FIGURE 16-26: CHANGE\_CFG COMMAND

31	16
	Op code
15	0
	Operand
31	16
CR	CFlag_High
15	0
CR	CFlag_Low

#### TABLE 16-15: CHANGE CFG FORMAT

Field	Description
Op code	0xB
Operand	Not used
CRCFlag	If the value is '0', the PE uses the software CRC calculation method. If the value is '1', the PE uses the hardware CRC unit to calculate the CRC.

Expected Response (1 word):

FIGURE 16-27: CHANGE_CFG RESPONSE	
31	16
	Last Command
15	0
	Response Code

Note:	The	command,	CHANGE	CFG,	is	not
	avail	able in PIC32	2MX1XX/2	2XX de	evice	es.

#### 16.2.15 GET CHECKSUM COMMAND

GET\_CHECKSUM returns the sum of all the bytes starting at the address argument up to the length argument. The result is a 32-bit word.

#### FIGURE 16-28: CHANGE\_CFG COMMAND

31		16
	Op code	
15		0
	Operand	
31		16
	Addr_High	
15		0
	Addr_Low	
31		16
	Length_High	
15		0
	Length_Low	

#### TABLE 16-16: GET\_CHECKSUM FORMAT

Field	Description
Op code	0x0C
Operand	Not used
Addr_High	High-order 16 bits of the 32-bit starting address of the data to calculate the checksum for.
Addr_Low	Low-order 16 bits of the 32-bit starting address of the data to calculate the checksum for.
Length_High	High-order 16 bits of the 32-bit length of data to calculate the checksum for in bytes.
Length_Low	Low-order 16 bits of the 32-bit length of data to calculate the checksum for in bytes.

#### Expected Response (1 word):

#### FIGURE 16-29: GET\_CHECKSUM RESPONSE

31		16
	Last Command	
15		0
	Response Code	
31		16
	Checksum_High	
15		0
	Checksum_Low	

#### 16.2.16 QUAD WORD PROGRAM COMMAND

QUAD\_WORD\_PROGRAM instructs the PE to program four, 32-bit words at the specified address. The address must be an aligned four word boundary (bits 0-1 must be '0'). If not, the command will return a FAIL response value and no data will be programmed.

FIGURE 16-30:	QUAD_WORD_PROGRAM
	COMMAND

31		16
	Op code	
15		0
	Operand	
31		16
	Addr_High	
15		0
	Addr_Low	
31		16
	Data0_High	
15		0
	Data0_Low	
31		16
	Data1_High	
15		0
	Data1_Low	
31		16
	Data2_High	
15		0
	Data2_Low	
31		16
	Data3_High	
15		0
	Data3_Low	

#### TABLE 16-17: QUAD\_WORD\_PROGRAM FORMAT

Field	Description
Op code	0x0C
Operand	Not used
Addr_High	High-order 16 bits of the 32-bit starting address.
Addr_Low	Low -order 16 bits of the 32-bit starting address.
Data0_High	High-order 16 bits of Data Word 0.
Data0_Low	Low-order 16 bits of Data Word 0.
Data1_High	High-order 16 bits of Data Word 1.
Data1_Low	Low-order 16 bits of Data Word 1.
Data2_High	High-order 16 bits of Data Word 2.
Data2_Low	Low-order 16 bits of Data Word 2.
Data3_High	High-order 16 bits of Data Word 3.
Data3_Low	Low-order 16 bits of Data Word 3.

#### Expected Response (1 word):

FIGURE 16-31:	QUAD_WORD_PROGRAM
	RESPONSE

31		16
	Last Command	
15		0
	Response Code	

## 17.0 CHECKSUM

## 17.1 Theory

The checksum is calculated as the 32-bit summation of all bytes (8-bit quantities) in program Flash, boot Flash (except device Configuration Words), the Device ID register with applicable mask, and the device Configuration Words with applicable masks. Next, the 2's complement of the summation is calculated. This final 32-bit number is presented as the checksum.

## 17.2 Mask Values

The mask value of a device Configuration is calculated by setting all the unimplemented bits to '0' and all the implemented bits to '1'.

For example, Register 17-1 shows the DEVCFG0 register of the PIC32MX360F512L device. The mask value for this register is:

mask\_value\_devcfg0 = 0x110FF00B

Table 17-1 lists the mask values of the four device Configuration registers and Device ID registers to be used in the checksum calculations.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	r-0	r-1	r-1	R/P-1	r-1	r-1	r-1	R/P-1
31:24	—	—	—	CP	—	—	—	BWP
00.40	r-1	r-1	r-1	r-1	R/P-1	R/P-1	R/P-1	R/P-1
23:16	—	—	—	—	PWP19	PWP18	PWP17	PWP16
45.0	R/P-1	R/P-1	R/P-1	R/P-1	r-1	r-1	r-1	r-1
15:8	PWP15	PWP14	PWP13	PWP12	—		—	—
7.0	r-1	r-1	r-1	r-1	R/P-1	r-1	R/P-1	R/P-1
7:0		—	—	_	ICESEL	_	DEBU	G<1:0>

#### REGISTER 17-1: DEVCFG0 REGISTER OF PIC32MX360F512L

Legend:	P = Programmable bit	r = Reserved bit	
R = Readable bit	W = Writable bit	U = Unimplemented bi	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

# TABLE 17-1:DEVICE CONFIGURATION REGISTER MASK VALUES OF CURRENTLY<br/>SUPPORTED PIC32 DEVICES

COLL OKLED	SUPPORTED FIG32 DEVICES					
Device	DEVCFG0	DEVCFG1	DEVCFG2	DEVCFG3	DEVID	
All PIC32MX1XX Family	0x1100FC1F	0x03DFF7A7	0x0070077	0xF0000000	0x0FFFFFFF	
All PIC32MX2XX Family	0x1100FC1F	0x03DFF7A7	0x0078777	0xF0000000	0x0FFFFFFF	
All PIC32MX320/340/360 Family	0x110FF00B	0x009FF7A7	0x00070077	0x0000000	0x000FF000	
All PIC32MX330/350/370 Family	0x110FF01F	0x03DFF7A7	0x00070077	0x30C70000	0x00FFFFFF	
All PIC32MX420/440/460 Family	0x110FF00B	0x009FF7A7	0x00078777	0x00000000	0x000FF000	
All PIC32MX430/450/470 Family	0x110FF01F	0x03DFF7A7	0x00078777	0xF0C70000	0x00FFFFFF	
All PIC32MZ EC Family	0x7FFFFFFF	0xFFFFFFFF	0xFFFFFFFF	0xFFFF0000	0x0FFFFFFF	
PIC32MX534F064H	0x110FF00F	0x009FF7A7	0x00078777	0xC4070000	0x0FFFF000	
PIC32MX534F064L	0x110FF00F	0x009FF7A7	0x00078777	0xC4070000	0x0FFFF000	
PIC32MX564F064H	0x110FF00F	0x009FF7A7	0x00078777	0xC4070000	0x0FFFF000	
PIC32MX564F064L	0x110FF00F	0x009FF7A7	0x00078777	0xC4070000	0x0FFFF000	
PIC32MX564F128H	0x110FF00F	0x009FF7A7	0x00078777	0xC4070000	0x0FFFF000	
PIC32MX564F128L	0x110FF00F	0x009FF7A7	0x00078777	0xC4070000	0x0FFFF000	
PIC32MX575F256H	0x110FF00F	0x009FF7A7	0x00078777	0xC4070000	0x000FF000	
PIC32MX575F256L	0x110FF00F	0x009FF7A7	0x00078777	0xC4070000	0x000FF000	
PIC32MX575F512H	0x110FF00F	0x009FF7A7	0x00078777	0xC4070000	0x000FF000	
PIC32MX575F512L	0x110FF00F	0x009FF7A7	0x00078777	0xC4070000	0x000FF000	
PIC32MX664F064H	0x110FF00F	0x009FF7A7	0x00078777	0xC3070000	0x0FFFF000	
PIC32MX664F064L	0x110FF00F	0x009FF7A7	0x00078777	0xC3070000	0x0FFFF000	
PIC32MX664F128H	0x110FF00F	0x009FF7A7	0x00078777	0xC3070000	0x0FFFF000	
PIC32MX664F128L	0x110FF00F	0x009FF7A7	0x00078777	0xC3070000	0x0FFFF000	
PIC32MX675F256H	0x110FF00F	0x009FF7A7	0x00078777	0xC3070000	0x000FF000	
PIC32MX675F256L	0x110FF00F	0x009FF7A7	0x00078777	0xC3070000	0x000FF000	
PIC32MX675F512H	0x110FF00F	0x009FF7A7	0x00078777	0xC3070000	0x000FF000	
PIC32MX675F512L	0x110FF00F	0x009FF7A7	0x00078777	0xC3070000	0x000FF000	
PIC32MX695F512H	0x110FF00F	0x009FF7A7	0x00078777	0xC3070000	0x000FF000	
PIC32MX695F512L	0x110FF00F	0x009FF7A7	0x00078777	0xC3070000	0x000FF000	
PIC32MX764F128H	0x110FF00F	0x009FF7A7	0x00078777	0xC7070000	0x0FFFF000	
PIC32MX764F128L	0x110FF00F	0x009FF7A7	0x00078777	0xC7070000	0x0FFFF000	
PIC32MX775F256H	0x110FF00F	0x009FF7A7	0x00078777	0xC7070000	0x000FF000	
PIC32MX775F256L	0x110FF00F	0x009FF7A7	0x00078777	0xC7070000	0x000FF000	
PIC32MX775F512H	0x110FF00F	0x009FF7A7	0x00078777	0xC7070000	0x000FF000	
PIC32MX775F512L	0x110FF00F	0x009FF7A7	0x00078777	0xC7070000	0x000FF000	
PIC32MX795F512H	0x110FF00F	0x009FF7A7	0x00078777	0xC7070000	0x000FF000	
PIC32MX795F512L	0x110FF00F	0x009FF7A7	0x00078777	0xC7070000	0x000FF000	

## 17.3 Algorithm

An example of a high-level algorithm for calculating the checksum for a PIC32 device is illustrated in Figure 17-1 to demonstrate one method to derive a checksum. This is merely an example of how the actual calculations can be accomplished, the method that is ultimately used is left to the discretion of the software developer.

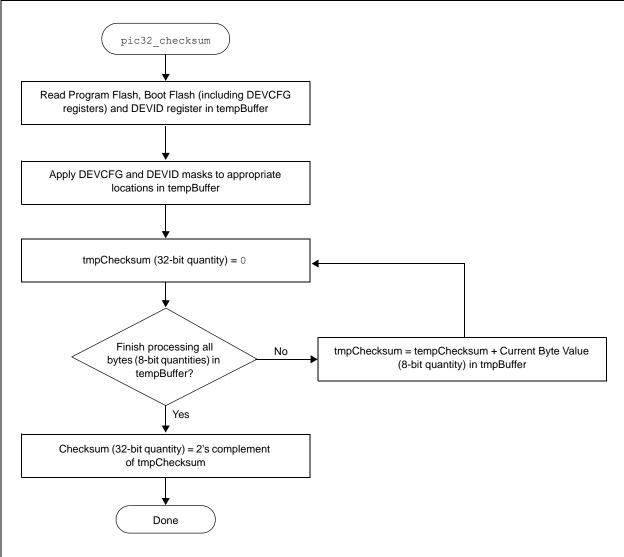
As stated earlier, the PIC32 checksum is calculated as the 32-bit summation of all bytes (8-bit quantities) in program Flash, boot Flash (except device Configuration Words), the Device ID register with applicable mask, and the device Configuration Words with applicable masks. Next, the 2's complement of the summation is calculated. This final 32-bit number is presented as the checksum.

The mask values of the device Configuration and Device ID registers are derived as described in the previous section, **Section 17.2** "Mask Values".

Another noteworthy point is that the last four 32-bit quantities in boot Flash are the device Configuration registers. An arithmetic AND operation of these device Configuration register values is performed with the appropriate mask value, before adding their bytes to the checksum.

Similarly, an arithmetic AND operation of the Device ID register is performed with the appropriate mask value, before adding its bytes to the checksum.





The formula to calculate the checksum for a PIC32 device is provided in Equation 17-1.

#### EQUATION 17-1: CHECKSUM FORMULA

Checksum = 2's complement (PF + BF + DCR + DIR)

Where,

PF = 32-bit summation of all bytes in Program Flash

BF = 32-bit summation of all bytes in boot Flash, except device Configuration registers

 $DCR = \sum_{X=0}^{5}$  32-bit summation of bytes (MASK<sub>DEVCFGX</sub> & DEVCFGx) X = 0

DIR = 32-bit summation of bytes ( $MASK_{DEVID} \& DEVID$ )

MASK<sub>DEVCFGX</sub> = mask value from Table 17-1

MASK<sub>DEVID</sub> = mask value from Table 17-1

#### 17.4 Example of Checksum Calculation

The following five sections demonstrate a checksum calculation for the PIC32MX360F512L device using Equation 17-1.

The following assumptions are made for the purpose of this checksum calculation example:

- Program Flash and boot Flash are in the erased state (all bytes are 0xFF)
- Device Configuration is in the default state of the device (no configuration changes are made)

To begin, each item on the right-hand side of the equation (PF, BF, DCR, DIR) is individually calculated. After those values have been derived, the final value of the checksum can be determined.

## 17.4.1 CALCULATING FOR "PF" IN THE CHECKSUM FORMULA

The size of Program Flash is 512 KB, which equals 524288 bytes. Since the program Flash is assumed to be in erased state, the value of "PF" is resolved through the following calculation:

PF = 0xFF + 0xFF + ... 524288 times

PF = 0x7F80000 (32-bit number)

#### 17.4.2 CALCULATING FOR "BF" IN THE CHECKSUM FORMULA

The size of the boot Flash is 12 KB, which equals 12288 bytes. However, the last 16 bytes are device Configuration registers, which are treated separately. Therefore, the number of bytes in boot Flash that we consider in this step is 12272. Since the boot Flash is assumed to be in erased state, the value of "BF" is resolved through the following calculation:

BF = 0xFF + 0xFF + ... 12272 times

BF = 0x002FC010 (32-bit number)

## 17.4.3 CALCULATING FOR "DCR" IN THE CHECKSUM FORMULA

Since the device Configuration registers are left in their default state, the value of the appropriate DEVCFG register – as read by the PIC32 core, its respective mask value, the value derived from applying the mask, and the 32-bit summation of bytes (all as shown in Table 17-2) provide the total of the 32-bit summation of bytes.

From Table 17-2, the value of "DCR" is:

DCR = 0x000003D6 (32-bit number)

Register	POR Default Value	Mask	POR Default Value & Mask	32-Bit Summation of Bytes
DEVCFG0	0x7FFFFFFF	0x110FF00B	0x110FF00B	0x0000011B
DEVCFG1	0xFFFFFFFF	0x009FF7A7	0x009FF7A7	0x0000023D
DEVCFG2	0xFFFFFFFF	0x00070077	0x00070077	0x000007E
DEVCFG3	0xFFFFFFFF	0x00000000	0x00000000	0x00000000
		Total of the 32-bit	Summation of Bytes =	0x000003D6

#### TABLE 17-2: DCR CALCULATION EXAMPLE

# 17.4.4 CALCULATING FOR "DIR" IN THE CHECKSUM FORMULA

The value of Device ID register, its mask value, the value derived from applying the mask, and the 32-bit summation of bytes are shown in Table 17-3.

From Table 17-3, the value of "DIR" is:

DIR = 0x00000083 (32-bit number.)

#### TABLE 17-3: DIR CALCULATION EXAMPLE

Register	POR Default Value	Mask	POR Default Value & Mask	32-Bit Summation of Bytes
DEVID	0x00938053	0x000FF000	0x00038000	0x0000083

#### 17.4.5 COMPLETING THE PIC32 CHECKSUM CALCULATION

The values derived in previous sections (PF, BF, DCR, DIR) are used to calculate the checksum value. First, perform the 32-bit summation of the PF, BF, DCR and DIR as derived in previous sections and store it in a variable, called *temp*, as shown in Example 17-1.

### EXAMPLE 17-1: CHECKSUM CALCULATION PROCESS

- 1. First, temp = PF + BF + DCR + DIR, which translates to:
  - *temp* = 0x7F80000 + 0x002FC010 + 0x000003D6 + 0x00000083
- 2. Adding all four values results in temp being equal to 0x0827C406
- Next, the 1's complement of *temp*, called *temp1*, is calculated: *temp1* = 1's complement (*temp*), which is now equal to 0xF7D83B96
- Finally, the 2's complement of *temp* is the checksum:
  Checksum = 2's complement (*temp*), which is Checksum = *temp1* + 1, resulting in 0xF7D83B97

#### 17.4.6 CHECKSUM VALUES WHILE DEVICE IS CODE-PROTECTED

Since the device Configuration Words are not readable while the PIC32 devices are in code-protected state, the checksum values are zeros for all devices.

## 18.0 CONFIGURATION MEMORY AND DEVICE ID

PIC32 devices include several features intended to maximize application flexibility and reliability, and minimize cost through elimination of external components. These features are configurable through specific Configuration bits for each device.

Refer to the "**Special Features**" chapter in the specific device data sheet for a full list of available features, Configuration bits, and the Device ID register.

See Table 18-4 for a full list of Device ID and revision number for specific devices.

## 18.1 Device Configuration

In PIC32 devices, the Configuration Words select various device configurations that are set at device Reset prior to execution of any code. These values are located at the highest locations of Boot Flash Memory (BFM) and since they are part of the program memory, are included in the programming file along with executable code and program constants. The names and locations of these Configuration Words are listed in Table 18-1 through Table 18-3.

Additionally, Table 18-3 includes Configuration Words for PIC32MZ EC family devices with dual boot and dual panel Flash. Refer to **Section 3. "Memory Organiza-***tion"* (DS61115) in the *"PIC32 Family Reference Manual"* for a detailed description of the dual boot regions.

TABLE 18-1:	DEVCFG LOCATIONS
-------------	------------------

Configuration Word	Physical Address
DEVCFG0	0x1FC02FFC
DEVCFG1	0x1FC02FF8
DEVCFG2	0x1FC02FF4
DEVCFG3	0x1FC02FF0

#### TABLE 18-2: DEVCFG LOCATIONS FOR PIC32MX1X0 AND PIC32MX20X DEVICES ONLY

Configuration Word	Physical Address
DEVCFG0	0x1FC00BFC
DEVCFG1	0x1FC00BF8
DEVCFG2	0x1FC00BF4
DEVCFG3	0x1FC00BF0

On Power-on Reset (POR), or any reset, the Configuration Words are copied from the boot Flash memory to their corresponding Configuration registers. A Configuration bit can only be programmed = 0 (unprogrammed state = 1). During programming, a Configuration Word can be programmed a maximum of two times for PIC32MX devices and only one time for PIC32MZ EC devices before a page erase must be performed.

After programming the Configuration Words, a device Reset will cause the new values to be loaded into the Configuration registers. Because of this, the programmer should program the Configuration Words just prior to verification of the device. The final step is programming the code protection Configuration Word.

These Configuration Words determine the oscillator source. If using the 2-wire Enhanced ICSP mode the Configuration Words are ignored and the device will always use the FRC; however, in 4-wire mode this is not the case. If an oscillator source is selected by the Configuration Words that is not present on the device after reset, the programmer will not be able to perform Flash operations on the device after it is reset. See the "**Special Features**" chapter in the specific device data sheet for details regarding oscillator selection using the Configuration Words.

	Register Physical Address				
Configuration Word (see Note 1)	Fixed Boot Region 1	Fixed Boot Region 2	Active Boot Alias Region (see Note 2)	Inactive Boot Alias Region (see Note 2)	
Boot Sequence Number	0x1FC4FFF0	0x1FC6FFF0	0x1FC0FFF0	0x1FC2FFF0	
Code Protection	0x1FC4FFD0	0x1FC6FFD0	0x1FC0FFD0	0x1FC2FFD0	
DEVCFG0	0x1FC4FFCC	0x1FC6FFCC	0x1FC0FFCC	0x1FC2FFCC	
DEVCFG1	0x1FC4FFC8	0x1FC6FFC8	0x1FC0FFC8	0x1FC2FFC8	
DEVCFG2	0x1FC4FFC4	0x1FC6FFC4	0x1FC0FFC4	0x1FC2FFC4	
DEVCFG3	0x1FC4FFC0	0x1FC6FFC0	0x1FC0FFC0	0x1FC2FFC0	
Alternate Boot Sequence Number	0x1FC4FF70	0x1FC6FF70	0x1FC0FF70	0x1FC2FF70	
Alternate Code Protection	0x1FC4FF50	0x1FC6FF50	0x1FC0FF50	0x1FC2FF50	
Alternate DEVCFG0	0x1FC4FF4C	0x1FC6FF4C	0x1FC0FF4C	0x1FC2FF4C	
Alternate DEVCFG1	0x1FC4FF48	0x1FC6FF48	0x1FC0FF48	0x1FC2FF48	
Alternate DEVCFG2	0x1FC4FF44	0x1FC6FF44	0x1FC0FF44	0x1FC2FF44	
Alternate DEVCFG3	0x1FC4FF40	0x1FC6FF40	0x1FC0FF40	0x1FC2FF40	

#### TABLE 18-3: CONFIGURATION WORD LOCATIONS FOR PIC32MZ EC FAMILY DEVICES

**Note 1:** Each of the following Configuration Word Groups should be programmed using the QUAD WORD PROGRAM command to insure proper ECC configuration:

- Boot Sequence Number (single quad word programming operation)
- Code Protection (single quad word programming operation)
- DEVCFG3, DEVCFG2, DEVCFG1, and DEVCFG0 (single quad word programming operation)
- Alternate Boot Sequence Number (single Quad Word programming operation)
- Alternate Code Protection (single Quad Word programming operation)
- Alternate DEVCFG3, alternate DEVCFG2, alternate DEVCFG1, and alternate DEVCFG0 (single quad word programming operation)
- 2: Active/Inactive boot alias selections are assumed for an unprogrammed device where Fixed Region 1 is active and Fixed Region 2 is inactive. Refer to **Section 3. "Memory Organization"** (DS61115) for a detailed description of the alias boot regions.

#### 18.1.1 CONFIGURATION REGISTER PROTECTION

To prevent inadvertent Configuration bit changes during code execution, all programmable Configuration bits are write-once. After a bit is initially programmed during a power cycle, it cannot be written to again. Changing a device configuration requires changing the Configuration data in the boot Flash memory, and cycling power to the device.

To ensure integrity of the 128-bit data, a comparison is made between each Configuration bit and its stored complement continuously. If a mismatch is detected, a Configuration Mismatch Reset is generated, which causes a device Reset.

Device	DEVID Register Value	<b>Revision ID and Silicon Revision</b>
PIC32MX110F016B	0x04A07053	
PIC32MX110F016C	0x04A09053	
PIC32MX110F016D	0x04A0B053	
PIC32MX120F032B	0x04A06053	
PIC32MX120F032C	0x04A08053	
PIC32MX120F032D	0x04A0A053	
PIC32MX130F064B	0x04D07053	
PIC32MX130F064C	0x04D09053	
PIC32MX130F064D	0x04D0B053	
PIC32MX150F128B	0x04D06053	
PIC32MX150F128C	0x04D08053	
PIC32MX150F128D	0x04D0A053	
PIC32MX210F016B	0x04A01053	
PIC32MX210F016C	0x04A03053	
PIC32MX210F016D	0x04A05053	
PIC32MX220F032B	0x04A00053	
PIC32MX220F032C	0x04A02053	
PIC32MX220F032D	0x04A04053	
PIC32MX230F064B	0x04D01053	
PIC32MX230F064C	0x04D03053	
PIC32MX230F064D	0x04D05053	0x0 – A0 Revision
PIC32MX250F128B	0x04D00053	
PIC32MX250F128C	0x04D02053	
PIC32MX250F128D	0x04D04053	
PIC32MX330F064H	0x05600053	
PIC32MX330F064L	0x05601053	
PIC32MX430F064H	0x05602053	
PIC32MX430F064L	0x05603053	
PIC32MX350F128H	0x0570C053	
PIC32MX350F128L	0x0570D053	
PIC32MX450F128H	0x0570E053	
PIC32MX450F128L	0x0570F053	
PIC32MX350F256H	0x05704053	
PIC32MX350F256L	0x05705053	
PIC32MX450F256H	0x05706053	
PIC32MX450F256L	0x05707053	
PIC32MX370F512H	0x05808053	
PIC32MX370F512L	0x05809053	
PIC32MX470F512H	0x0580A053	
PIC32MX470F512L	0x0580B053	

#### TABLE 18-4: DEVICE IDs AND REVISION

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Device	DEVID Register Value	<b>Revision ID and Silicon Revision</b>
PIC32MX360F512L	0x0938053	
PIC32MX360F256L	0x0934053	
PIC32MX340F128L	0x092D053	
PIC32MX320F128L	0x092A053	
PIC32MX340F512H	0x0916053	
PIC32MX340F256H	0x0912053	
PIC32MX340F128H	0x090D053	
PIC32MX320F128H	0x090A053	0x3 – B2 Revision
PIC32MX320F064H	0x0906053	0x4 – B3 Revision 0x5 – B4 Revision
PIC32MX320F032H	0x0902053	0x5 – B6 Revision
PIC32MX460F512L	0x0978053	
PIC32MX460F256L	0x0974053	
PIC32MX440F128L	0x096D053	
PIC32MX440F256H	0x0952053	
PIC32MX440F512H	0x0956053	
PIC32MX440F128H	0x094D053	
PIC32MX420F032H	0x0942053	
PIC32MX534F064H	0x4400053	
PIC32MX534F064L	0x440C053	
PIC32MX564F064H	0x4401053	
PIC32MX564F064L	0x440D053	
PIC32MX564F128H	0x4403053	
PIC32MX564F128L	0x440F053	
PIC32MX575F256H	0x4317053	
PIC32MX575F256L	0x4333053	
PIC32MX575F512H	0x4309053	
PIC32MX575F512L	0x430F053	
PIC32MX664F064H	0x4405053	
PIC32MX664F064L	0x4411053	
PIC32MX664F128H	0x4407053	
PIC32MX664F128L	0x4413053	0x0 – A0 Revision
PIC32MX675F256H	0x430B053	0x1 – A1 Revision
PIC32MX675F256L	0x4305053	
PIC32MX675F512H	0x430C053	
PIC32MX675F512L	0x4311053	
PIC32MX695F512H	0x4325053	
PIC32MX695F512L	0x4341053	-
PIC32MX764F128H	0x440B053	
PIC32MX764F128L	0x4417053	
PIC32MX775F256H	0x4303053	
PIC32MX775F256L	0x4312053	
PIC32MX775F512H	0x430D053	
PIC32MX775F512L	0x4306053	
PIC32MX795F512H	0x430E053	
PIC32MX795F512L	0x4307053	

## TABLE 18-4: DEVICE IDs AND REVISION (CONTINUED)

Device	DEVID Register Value	<b>Revision ID and Silicon Revision</b>
PIC32MZ0256ECE064	0x05100053	
PIC32MZ0256ECE100	0x0510A053	
PIC32MZ0256ECE124	0x05114053	
PIC32MZ0256ECE144	0x0511E053	
PIC32MZ0256ECF064	0x05105053	
PIC32MZ0256ECF100	0x0510F053	
PIC32MZ0256ECF124	0x05119053	
PIC32MZ0256ECF144	0x05123053	
PIC32MZ0512ECE064	0x05101053	
PIC32MZ0512ECE100	0x0510B053	
PIC32MZ0512ECE124	0x05115053	
PIC32MZ0512ECE144	0x0511F053	
PIC32MZ0512ECF064	0x05106053	
PIC32MZ0512ECF100	0x05110053	
PIC32MZ0512ECF124	0x0511A053	
PIC32MZ0512ECF144	0x05124053	
PIC32MZ1024ECE064	0x05102053	0x0 – A0 Revision
PIC32MZ1024ECE100	0x0510C053	
PIC32MZ1024ECE124	0x05116053	
PIC32MZ1024ECE144	0x05120053	
PIC32MZ1024ECF064	0x05107053	
PIC32MZ1024ECF100	0x05111053	
PIC32MZ1024ECF124	0x0511B053	
PIC32MZ1024ECF144	0x05125053	
PIC32MZ1024ECG064	0x05103053	
PIC32MZ1024ECG100	0x0510D053	
PIC32MZ1024ECG124	0x05117053	
PIC32MZ1024ECG144	0x05121053	
PIC32MZ1024ECH064	0x05108053	
PIC32MZ1024ECH100	0x05112053	
PIC32MZ1024ECH124	0x0511C053	
PIC32MZ1024ECH144	0x05126053	
PIC32MZ2048ECG064	0x05104053	
PIC32MZ2048ECG100	0x0510E053	
PIC32MZ2048ECG124	0x05118053	
PIC32MZ2048ECG144	0x05122053	
PIC32MZ2048ECH064	0x05109053	0x0 – A0 Revision
PIC32MZ2048ECH100	0x05113053	
PIC32MZ2048ECH124	0x0511D053	
PIC32MZ2048ECH144	0x05127053	

## TABLE 18-4: DEVICE IDs AND REVISION (CONTINUED)

### 18.2 Device Code Protection bit (CP)

The PIC32 family of devices feature code protection, which when enabled, prevents reading of Flash memory by an external programming device. Once code protection is enabled, it can only be disabled by erasing the device with the Chip Erase command (MCHP\_ERASE).

When programming a device that has opted to utilize code protection, the programming device must perform verification prior to enabling code protection. Enabling code protection should be the last step of the programming process. Location of the code protection enable bits vary by device. Refer to the "**Special Features**" chapter in the specific device data sheet for details.

Note:	Once code protection is enabled, the
	Flash memory can no longer be read and
	can only be disabled by an external pro-
	grammer using the Chip Erase Command
	(MCHP_ERASE).

#### **18.3** Program Write Protection bits (PWP)

The PIC32 families of devices include write protection features, which prevent designated boot and program Flash regions from being erased or written during program execution.

In PIC32MX devices, write protection is implemented in Configuration memory by the Device Configuration Words, while in PIC32MZ EC devices, this feature is implemented through Special Function Registers (SFRs) in the Flash controller.

When write protection is implemented by Device Configuration Words, the write protection register should only be written when all boot and program Flash memory has been programmed. Refer to the **"Special Features"** chapter in the specific device data sheet for details.

If write protection is implemented using SFRs, certain steps may be required during initialization of the device by the external programmer prior to programming Flash regions. Refer to the "**Flash Program Memory**" chapter in the specific device data sheet for details.

## 19.0 TAP CONTROLLERS

#### TABLE 19-1: MCHP TAP INSTRUCTIONS

Command	Value	Description			
MTAP_COMMAND	5'h0x07	TDI and TDO connected to MCHP Command Shift register (See Table 19-2).			
MTAP_SW_MTAP	5'h0x04	Switch TAP controller to MCHP TAP controller.			
MTAP_SW_ETAP	5'h0x05	Switch TAP controller to EJTAG TAP controller.			
MTAP_IDCODE	5'h0x01	Select Chip Identification Data register.			

#### **19.1 Microchip TAP Controllers (MTAP)**

#### 19.1.1 MTAP COMMAND INSTRUCTION

MTAP\_COMMAND selects the MCHP Command Shift register. See Table 19-2 for available commands.

#### 19.1.1.1 MCHP STATUS INSTRUCTION

MCHP\_STATUS returns the 8-bit Status value of the Microchip TAP controller. Table 19-3 shows the format of the Status value returned.

#### 19.1.1.2 MCHP ASSERT RST INSTRUCTION

MCHP\_ASSERT\_RST performs a persistent device Reset. It is similar to asserting and holding MCLR. Its associated Status bit is DEVRST.

#### 19.1.1.3 MCHP\_DE\_ASSERT\_RST INSTRUCTION

MCHP\_DE\_ASSERT\_RST removes the persistent device Reset. It is similar to de-asserting MCLR. Its associated Status bit is DEVRST.

#### **19.1.1.4** MCHP ERASE **INSTRUCTION**

MCHP\_ERASE performs a Chip Erase. The CHIP\_ ERASE command sets an internal bit that requests the Flash Controller to perform the erase. Once the controller becomes busy, as indicated by FCBUSY (Status bit), the internal bit is cleared.

## 19.1.1.5 MCHP\_FLASH\_ENABLE INSTRUCTION

MCHP\_FLASH\_ENABLE sets the FAEN bit, which controls processor accesses to the Flash memory. The FAEN bit's state is returned in the field of the same name. This command has no effect if CPS = 0. This command requires a NOP to complete.

Note: This command is not required for PIC32MZ EC family devices.

#### 19.1.1.6 MCHP\_FLASH\_DISABLE INSTRUCTION

MCHP\_FLASH\_DISABLE clears the FAEN bit which controls processor accesses to the Flash memory. The FAEN bit's state is returned in the field of the same name. This command has no effect if CPS = 0. This command requires a NOP to complete.

Note: This command is not required for PIC32MZ EC family devices.

#### 19.1.2 MTAP SW MTAP INSTRUCTION

 $\tt MTAP\_SW\_MTAP$  switches the TAP instruction set to the MCHP TAP instruction set.

#### 19.1.3 MTAP SW ETAP INSTRUCTION

#### 19.1.4 MTAP IDCODE INSTRUCTION

MTAP\_IDCODE returns the value stored in the DEVID register.

Command	Value	Description				
MCHP_STATUS 8'h0x00		NOP and return Status.				
MCHP_ASSERT_RST 8'h0xD1		Requests the reset controller to assert device Reset.				
MCHP_DE_ASSERT_RST	8'h0xD0	Removes the request for device Reset, which causes the reset controller to de-assert device Reset if there is no other source requesting Reset (i.e., MCLR).				
MCHP_ERASE	8'h0xFC	Cause the Flash controller to perform a Chip Erase.				
MCHP_FLASH_ENABLE <sup>(1)</sup>	8'h0xFE	Enables fetches and loads to the Flash (from the processor).				
MCHP_FLASH_DISABLE <sup>(1)</sup>	8'h0xFD	Disables fetches and loads to the Flash (from the processor).				

#### TABLE 19-2: MTAP\_COMMAND DR COMMANDS

**Note 1:** This command is not required for PIC32MZ EC family devices.

### TABLE 19-3: MCHP STATUS VALUE

Bit Range	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
7:0	CPS	0	NVMERR <sup>(1)</sup>	0	CFGRDY	FCBUSY	FAEN <sup>(2)</sup>	DEVRST

bit 7	CPS: Code-Protect State bit
	1 = Device is not code-protected
1.11.0	0 = Device is code-protected
bit 6	Unimplemented: Read as '0'
bit 5	NVMERR: NVMCON Status bit <sup>(1)</sup>
	1 = An Error occurred during NVM operation
	0 = An Error did not occur during NVM operation
bit 4	Unimplemented: Read as '0'
bit 3	CFGRDY: Code-Protect State bit
	1 = Configuration has been read and CP is valid
	0 = Configuration has not been read
bit 2	FCBUSY: Flash Controller Busy bit
	1 = Flash controller is busy (Erase is in progress)
	0 = Flash controller is not busy (either erase has not started or it has finished)
bit 1	FAEN: Flash Access Enable bit <sup>(2)</sup>
	This bit reflects the state of CFGCON.FAEN.
	1 = Flash access is enabled
	0 = Flash access is disabled (i.e., processor accesses are blocked)
bit 0	DEVRST: Device Reset State bit
	1 = Device Reset is active
	0 = Device Reset is not active
Note 1:	This bit is not implemented in PIC32MX320/340/360/420/440/460 devices.

2: This bit is not implemented in PIC32MZ EC family devices.

Command Value		Description			
ETAP_ADDRESS	5'h0x08	Select Address register.			
ETAP_DATA	5'h0x09	Select Data register.			
ETAP_CONTROL	5'h0x0A	Select EJTAG Control register.			
ETAP_EJTAGBOOT	5'h0x0C	Set EjtagBrk, ProbEn and ProbTrap to '1' as the reset value.			
ETAP_FASTDATA	5'h0x0E	Selects the Data and Fastdata registers.			

### **19.2 EJTAG TAP Controller**

#### 19.2.1 ETAP ADDRESS COMMAND

ETAP\_ADDRESS selects the Address register. The read-only Address register provides the address for a processor access. The value read in the register is valid if a processor access is pending, otherwise the value is undefined.

The two or three Least Significant Bytes (LSBs) of the register are used with the Psz field from the EJTAG Control register to indicate the size and data position of the pending processor access transfer. These bits are not taken directly from the address referenced by the load/store.

#### 19.2.2 ETAP DATA COMMAND

ETAP\_DATA selects the Data register. The read/write Data register is used for op code and data transfers during processor accesses. The value read in the Data register is valid only if a processor access for a write is pending, in which case the Data register holds the store value. The value written to the Data register is only used if a processor access for a pending read is finished afterwards; in which case, the data value written is the value for the fetch or load. This behavior implies that the Data register is not a memory location where a previously written value can be read afterwards.

#### 19.2.3 ETAP\_CONTROL COMMAND

ETAP\_CONTROL selects the Control register. The EJTAG Control register (ECR) handles processor Reset and soft Reset indication, Debug mode indication, access start, finish and size, and read/write indication. The ECR also provides the following features:

- Controls debug vector location and indication of serviced processor accesses
- Allows a debug interrupt request
- · Indicates a processor low-power mode
- Allows implementation-dependent processor and peripheral Resets

#### 19.2.3.1 EJTAG Control Register (ECR)

The EJTAG Control register (see Register 19-1) is not updated/written in the Update-DR state unless the Reset occurred; that is Rocc (bit 31) is either already '0' or is written to '0' at the same time. This condition ensures proper handling of processor accesses after a Reset.

Reset of the processor can be indicated through the Rocc bit in the TCK domain a number of TCK cycles after it is removed in the processor clock domain in order to allow for proper synchronization between the two clock domains.

Bits that are Read/Write (R/W) in the register return their written value on a subsequent read, unless other behavior is defined.

Internal synchronization ensures that a written value is updated for reading immediately afterwards, even when the TAP controller takes the shortest path from the Update-DR to Capture-DR state.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04-04	R/W-0	R-0	R-0	U-0	U-0	U-0	U-0	U-0
31:24	Rocc	Psz<1:0>		—	—		—	—
23:16	R-0	R-0	R-0	R/W-0	R-0	R/W-0	U-0	R/W-0
23.10	VPED	Doze	Halt	PerRst	PrnW	PrACC	—	PrRst
15:8	R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0
15.0	ProbEn	ProbTrap	—	EjtagBrk	—	—	—	—
7:0	U-0	U-0	U-0	U-0	R-0	U-0	U-0	U-0
7.0	—	—	—	—	DM	—	—	—
Legend:								
R = Read	able bit		W = Writable	bit	U = Unimple	emented bit, rea	ad as '0'	
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown		
bit 31-29 See Note 1								
bit 28-24	Unimpleme	nted: Read a	<b>s</b> '0'					

#### REGISTER 19-1: ECR: EJTAG CONTROL REGISTER

#### bit 23-19 See Note 1

bit 18 PrACC: Pending Processor Access and Control bit

This bit indicates a pending processor access and controls finishing of a pending processor access. A write of '0' finishes processor access if pending. A write of '1' is ignored. A successful FASTDATA access will clear this bit.

1 = Pending processor access

0 = No pending preprocessor access

bit 17 Unimplemented: Read as '0'

#### bit 16 See Note 1

bit 15 **ProbEn:** Processor Access Service Control bit

This bit controls where the probe handles accesses to the DMSEG segment through servicing of processor accesses.

- 1 = Probe services processor accesses
- 0 = Probe does not service processor access
- bit 14 **ProbTrap:** Debug Exception Vector Control Location bit

This bit controls the location of the debug exception vector.

- 1 = 0xFF200200
- 0 = 0xBFC00480

#### bit 13 Unimplemented: Read as '0'

bit 12 **EjtagBrk:** Debug Interrupt Exception Request bit

This bit requests a debug interrupt exception to the processor when this bit is written as '1'. A write of '0' is ignored.

- 1 = A debug interrupt exception request is pending
- 0 = A debug interrupt exception request is not pending
- bit 11-4 Unimplemented: Read as '0'
- bit 3 See Note 1
- bit 2-0 Unimplemented: Read as '0'
- **Note 1:** For descriptions of these bits, please refer to the EJTAG Control Register Field Descriptions in the *"EJTAG Specification"* (MD00047), which is available from MIPS Technologies, Inc. (www.mips.com).

#### 19.2.4 ETAP EJTAGBOOT COMMAND

The ETAP\_EJTAGBOOT command causes the processor to fetch code from the debug exception vector after a reset. This allows the programmer to send instructions to the processor to execute, instead of the processor fetching them from the normal reset vector. The Reset value of the EjtagBrk, ProbTrap, and ProbE bits follows the setting of the internal EJTAGBOOT indication.

If the EJTAGBOOT instruction has been given, and the internal EJTAGBOOT indication is active, then the Reset value of the three bits is set ('1'), otherwise the Reset value is clear ('0').

The results of setting these bits are:

- Setting the EjtagBrk causes a Debug interrupt exception to be requested right after the processor Reset from the EJTAGBOOT instruction
- The debug handler is executed from the EJTAG memory because ProbTrap is set to indicate debug vector in EJTAG memory at 0xFF200200
- Service of the processor access is indicated because ProbEn is set

With this configuration in place, an interrupt exception will occur and the processor will fetch the handler from the DMSEG at 0xFF200200. Since ProbEn is set, the processor will wait for the instruction to be provided by the probe.

#### 19.2.5 ETAP FASTDATA COMMAND

ETAP FASTDATA command The provides а mechanism for quickly transferring data between the processor and the probe. The width of the Fastdata register is one bit. During a fast data access, the Fastdata register is written and read (i.e., a bit is shifted in and a bit is shifted out). During a fast data access, the Fastdata register value shifted in specifies whether the fast data access should be completed or not. The value shifted out is a flag that indicates whether the fast data access was successful or not (if completion was requested). The FASTDATA access is used for efficient block transfers between the DMSEG segment (on the probe) and target memory (on the processor). An "upload" is defined as a sequence that the processor loads from target memory and stores to the DMSEG segment. A "download" is a sequence of processor loads from the DMSEG segment and stores to target memory. The "Fastdata area" specifies the legal range of DMSEG segment addresses (0xFF200000 to 0xFF20000F) that can be used for uploads and downloads. The Data and Fastdata registers (selected with the FASTDATA instruction) allow efficient completion of pending Fastdata area accesses.

During Fastdata uploads and downloads, the processor will stall on accesses to the Fastdata area. The PrAcc (processor access pending bit) will be '1' indicating the probe is required to complete the access. Both upload and download accesses are attempted by shifting in a zero SPrAcc value (to request access completion) and shifting out SPrAcc to see if the attempt will be successful (i.e., there was an access pending and a legal Fastdata area address was used).

Downloads will also shift in the data to be used to satisfy the load from the DMSEG segment Fastdata area, while uploads will shift out the data being stored to the DMSEG segment Fastdata area.

As noted above, two conditions must be true for the Fastdata access to succeed. These are:

- PrAcc must be '1' (i.e., there must be a pending processor access)
- The Fastdata operation must use a valid Fastdata area address in the DMSEG segment (0xFF200000 to 0xFF20000F)

## 20.0 AC/DC CHARACTERISTICS AND TIMING REQUIREMENTS

## TABLE 20-1: AC/DC CHARACTERISTICS AND TIMING REQUIREMENTS

#### **Standard Operating Conditions**

Operating Temperature: 0°C to +70°C. Programming at +25°C is recommended.

Operating Temperature: 0°C to +70°C. Programming at +25°C is recommended.								
Param. No.	Symbol	Characteristic		Max.	Units	Conditions		
D111	Vdd	Supply Voltage During Programming		_	V	See Note 1		
D113	IDDP	Supply Current During Programming	—	—	mA	See Note 1		
D114	IPEAK	Instantaneous Peak Current During Start-up	—	—	mA	See Note 1		
D031	VIL	Input Low Voltage	—	—	V	See Note 1		
D041	Vih	Input High Voltage	—	—	V	See Note 1		
D080	Vol	Output Low Voltage	—	—	V	See Note 1		
D090	Vон	Output High Voltage	—	—	V	See Note 1		
D012	Сю	Capacitive Loading on I/O pin (PGEDx)	—	—	pF	See Note 1		
D013	CF	Filter Capacitor Value on VCAP	—	—	μF	See Note 1		
P1	TPGC	Serial Clock (PGECx) Period	100	—	ns	—		
P1A	TPGCL	Serial Clock (PGECx) Low Time	40	—	ns	—		
P1B	TPGCH	Serial Clock (PGECx) High Time		—	ns	—		
P6	TSET2	VDD ↑ Setup Time to MCLR ↑		_	ns	_		
P7	THLD2	Input Data Hold Time from $\overline{\text{MCLR}}$ $\uparrow$	500		ns			
P9A	TDLY4	PE Command Processing Time	40	_	μs	—		
P9B	TDLY5	Delay between PGEDx ↓ by the PE to PGEDx Released by the PE		—	μS	_		
P11	TDLY7	Chip Erase Time			ms	See Note 1		
P12	TDLY8	Page Erase Time			ms	See Note 1		
P13	TDLY9	Row Programming Time	_	—	ms	See Note 1		
P14	TR	MCLR Rise Time to Enter ICSP™ mode		1.0	μs	_		
P15	TVALID	Data Out Valid from PGECx ↑	10		ns			
P16	TDLY8	Delay between Last PGECx $\downarrow$ and $\overline{MCLR}$ $\downarrow$	0		S	—		
P17	THLD3	$\overline{MCLR}\downarrow$ to VDD $\downarrow$	—	100	ns	_		
P18	Τκεγ1	Delay from First $\overline{\text{MCLR}} \downarrow$ to First PGECx $\uparrow$ for Key Sequence on PGEDx		—	ns	—		
P19	Τκεγ2	Delay from Last PGECx $\downarrow$ for Key Sequence on PGEDx to Second MCLR $\uparrow$	40	—	ns	—		
P20	TMCLRH	MCLR High Time	_	500	μs			

**Note 1:** Refer to the "**Electrical Characteristics**" chapter in the specific device data sheet for the Minimum and Maximum values for this parameter.

## APPENDIX A: PIC32 FLASH MEMORY MAP

#### FIGURE A-1: FLASH MEMORY MAP

0x1D000000 ΡFM Program Flash Memory 0x1D007FFF 0x1F000000 Boot Page 0 Boot Page 1 BFM 0x1F001FFF Boot Page 2 Debug Page 0x1F002FF0 Configuration Words (4 x 32 bits) 0x1F002FFF Note: The memory map shown is for reference only. Refer to the "Memory Organization" chapter in the specific device data sheet for the memory map for your device.

## APPENDIX B: HEX FILE FORMAT

Flash programmers process the standard hexadecimal (hex) format used by the Microchip development tools. The format supported is the Intel<sup>®</sup> HEX32 Format (INHX32). Please refer to **Section 1.75** "**Hex file Formats**" in the "MPASM<sup>TM</sup> Assembler, MPLINK<sup>TM</sup> Object Linker, MPLIB<sup>TM</sup> Object Librarian User's Guide" (DS33014) for more information about hex file formats.

The basic format of the hex file is:

:ВВААААТТНННН...ННННСС

Each data record begins with a 9-character prefix and always ends with a 2-character checksum. All records begin with ':', regardless of the format. The individual elements are described below.

- BB is a two-digit hexadecimal byte count representing the number of data bytes that appear on the line. Divide this number by two to get the number of words per line.
- AAAA is a four-digit hexadecimal address representing the starting address of the data record. Format is high byte first followed by low byte. The address is doubled because this format only supports 8 bits. Divide the value by two to find the real device address.
- TT is a two-digit record type that will be '00' for data records, '01' for end-of-file records and '04' for extended-address record.
- HHHH is a four-digit hexadecimal data word. Format is low byte followed by high byte. There will be BB/2 data words following TT.
- CC is a two-digit hexadecimal checksum that is the 2's complement of the sum of all the preceding bytes in the line record.

Because the Intel hex file format is byte-oriented, and the 16-bit program counter is not, program memory sections require special treatment. Each 24-bit program word is extended to 32 bits by inserting a socalled "phantom byte". Each program memory address is multiplied by 2 to yield a byte address.

As an example, a section that is located at 0x100 in program memory will be represented in the hex file as 0x200.

The hex file will be produced with the following contents:

```
:020000040000fa
:040200003322110096
:00000001FF
```

Notice that the data record (line 2) has a load address of 0200, while the source code specified address 0x100. Note also that the data is represented in "little-endian" format, meaning the Least Significant Byte appears first. The phantom byte appears last, just before the checksum.

## APPENDIX C: REVISION HISTORY

## **Revision A (August 2007)**

This is the initial released version of the document.

## **Revision B (February 2008)**

Update records for this revision are not available.

## **Revision C (April 2008)**

Update records for this revision are not available.

## Revision D (May 2008)

Update records for this revision are not available.

## Revision E (July 2009)

This version of the document includes the following additions and updates:

- Minor changes to style and formatting have been incorporated throughout the document
- Added the following devices:
  - PIC32MX565F256H
  - PIC32MX575F512H
  - PIC32MX675F512H
  - PIC32MX795F512H
  - PIC32MX575F512L
  - PIC32MX675F512L
  - PIC32MX795F512L
- Updated MCLR pulse line to show active-high (P20) in Figure 7-1
- Updated Step 7 of Table 11-1 to clarify repeat of the *last* instruction in the step
- The following instructions in Table 13-1 were updated:
  - Seventh, ninth and eleventh instructions in Step 1
  - All instructions in Step 2
  - First instruction in Step 3
  - Third instruction in Step 4
- Added the following devices to Table 17-1:
  - PIC32MX565F256H
  - PIC32MX575F512H
  - PIC32MX575F512L
  - PIC32MX675F512H
  - PIC32MX675F512L
  - PIC32MX795F512H
  - PIC32MX795F512L
- Updated address values in Table 17-2

#### Revision E (July 2009) (Continued)

- Added the following devices to Table 17-5:
  - PIC32MX565F256H
  - PIC32MX575F512H
  - PIC32MX675F512H
  - PIC32MX795F512H
  - PIC32MX575F512L
  - PIC32MX675F512L
  - PIC32MX795F512L
- Added Notes 1-3 and the following bits to the DEVCFG Device Configuration Word Summary and the DEVCFG3: Device Configuration Word 3 (see Table 18-1 and Register ):
  - FVBUSIO
  - FUSBIDIO
  - FCANIO
  - FETHIO
  - FMIIEN
  - FPBDIV<1:0>
  - FJTAGEN
- Updated the DEVID Summary (see Table 18-1)
- Updated ICESEL bit description and added the FJTAGEN bit in DEVCFG0: Device Configuration Word 0 (see Register 16-1)
- Updated DEVID: Device and Revision ID register
- Added Device IDs and Revision table (Table 18-4)
- Added MCLR High Time (parameter P20) to Table 20-1
- Added Appendix B: "Hex File Format" and Appendix D: "Revision History"

## **Revision F (April 2010)**

This version of the document includes the following additions and updates:

- The following global bit name changes were made:
  - NVMWR renamed as WR
  - NVMWREN renamed as WREN
  - NVMERR renamed as WRERR
  - FVBUSIO renamed as FVBUSONIO
  - FUPLLEN renamed as UPLLEN
  - FUPLLIDIV renamed as UPLLIDIV
  - POSCMD renamed as POSCMOD
- Updated the PIC32MX family data sheet references in the fourth paragraph of Section 2.0 "Programming Overview"
- Updated the note in Section 5.2.2 "2-Phase ICSP"
- Updated the Initiate Flash Row Write Op Codes and instructions (see steps 4, 5 and 6 in Table 13-1)

## **Revision F (April 2010) (Continued)**

- Added the following devices:
  - PIC32MX534F064H
  - PIC32MX534F064L
  - PIC32MX564F064H
  - PIC32MX564F064L
  - PIC32MX564F128H
  - PIC32MX564F128L
  - PIC32MX575F256L
  - PIC32MX664F064H
  - PIC32MX664F064L
  - PIC32MX664F128H
  - PIC32MX664F128L
  - PIC32MX675F256H
  - PIC32MX675F256L
  - PIC32MX695F512H
  - PIC32MX605F512L
  - PIC32MX764F128H
  - PIC32MX764F128L
  - PIC32MX775F256H
  - PIC32MX775F256L
  - PIC32MX775F512H
  - PIC32MX775F512L

### **Revision G (August 2010)**

This revision of the document includes the following updates:

- Updated Step 3 in Table 11-1: Download the PE
- Minor corrections to formatting and text have been incorporated throughout the document

## **Revision H (April 2011)**

This version of the document includes the following additions and updates:

- Updates to formatting and minor typographical changes have been incorporated throughout the document
- The following devices were added:
  - PIC32MX110F016B
  - PIC32MX110F016C
  - PIC32MX110F016D
  - PIC32MX120F032B
  - PIC32MX120F032C
  - PIC32MX120F032D
  - PIC32MX210F016B
  - PIC32MX210F016C
  - PIC32MX210F016D
  - PIC32MX220F032B
  - PIC32MX220F032C
  - PIC32MX220F032D
- The following rows were added to Table 17-1:
  - PIC32MX1X0
  - PIC32MX2X0
- Added a new sub section Section 17.4.6 "Checksum Values While Device Is Code-Protected"

- Removed Register 18-1 through Register 18-5.
- Removed Table 17-2
- Removed Section 17.5 "Checksum for PIC32 Devices" and its sub sections
- The Flash Program Memory Write-Protect Ranges table was removed (formerly Table 18-4)
- Added DEVCFG Locations for PIC32MX1X0 and PIC32MX20X Devices Only (see Table 18-3)
- In Section 18.0 "Configuration Memory and Device ID", removed Table 18-1 and updated Table 18-2: DEVID Summary as Table 18-1
- Added the NVMERR bit to the MCHP Status Value table (see Table 19-3)
- The following Silicon Revision and Revision ID are added to Table 18-4:
  - 0x5 B6 Revision
  - 0x1 A1 Revision
- Added a note to the Flash Memory Map (see Figure A-1)
- Added Appendix C: "Flash Program Memory Data Sheet Clarification"

## **Revision J (August 2011)**

Note: The revision history in this document intentionally skips from Revision H to Revision J to avoid confusing the uppercase letter "I" (EY) with the lowercase letter "I" (EL).

This revision includes the following updates:

- All occurrences of VCORE/VCAP have been changed to VCAP
- Updated the fourth paragraph of Section 2.0 "Programming Overview"
- Removed the column, Programmer Pin Name, from the 2-Wire Interface Pins table and updated the Pin Type for MCLR (see Table 4-2)
- Added the following new devices to the Code Memory Size table (see Table 5-1) and the Device IDs and Revision table (see Table 18-4):
  - PIC32MX130F064B
  - PIC32MX130F064C
  - PIC32MX130F064D
  - PIC32MX150F128B
  - PIC32MX150F128C
  - PIC32MX150F128D
  - PIC32MX230F064B
  - PIC32MX230F064C
  - PIC32MX230F064D
  - PIC32MX250F128B
  - PIC32MX250F128C
  - PIC32MX250F128D
- Added Row Size and Page Size columns to the Code Memory Size table (see Table 5-1)

## Revision J (August 2011) (Continued)

- Updated the PGCx signal in Entering Enhanced ICSP Mode (see Figure 7-1)
- Updated the Erase Device block diagram (see Figure 9-1)
- Added a new step 4 to the process to erase a target device in Section 9.0 "Erasing the Device"
- Updated the MCLR signal in 2-Wire Exit Test Mode (see Figure 15-2)
- Updated the PE Command Set with the following commands and modified Note 2 (see Table 16-2):
  - PROGRAM\_CLUSTER
  - GET DEVICEID
  - CHANGE CFG
- Added a second note to Section 16.2.11 "GET\_CRC Command"
- Updated the Address and Length descriptions in the PROGRAM\_CLUSTER Format (see Table 16-13)
- Added a note after the CHANGE\_CFG Response (see Figure 16-27)
- Updated the DEVCFG0 and DEVCFG1 values for All PIC32MX1XX and All PIC32MX2XX devices in Table 17-1
- The following changes were made to the AC/DC Characteristics and Timing Requirements (Table 20-1):
  - Updated the Min. value for parameter D111 (VDD)
  - Added parameter D114 (IPEAK)
  - Removed parameters P2, P3, P4, P4A, P5, P8 and P10
- Removed Appendix C: "Flash Program Memory Data Sheet Clarification"
- Minor updates to text and formatting were incorporated throughout the document

## Revision K (July 2012)

This revision includes the following updates:

- All occurrences of PGC and PGD were changed to: PGEC and PGED, respectively
- Updated **Section 1.0 "Device Overview**" with a list of all major topics in this document
- Added Section 2.3 "Data Sizes"
- Updated Section 4.0 "Connecting to the Device"
- Added Note 2 to Connections for the On-chip Regulator (see Figure 4-2)
- Added Note 2 to the 4-wire and 2-wire Interface Pins tables (see Table 4-1 and Table 4-2)
- Updated Section 7.0 "Entering 2-Wire Enhanced ICSP Mode"
- Updated Entering Serial Execution Mode (see Figure 10-1)
- Updated step 11 in Section 10.2 "2-wire Interface"

- Updated Section 12.2 "With the PE"
- Updated Step 3 in Initiate Flash Row Write Op Codes (see Table 13-1)
- Updated Step 1 in Verify Device Op Codes (see Table 14-1)
- Updated the interval in Section 15.1 "4-wire Interface" and Section 15.2 "2-wire Interface"
- Added a note regarding the PE location in Section 16.0 "The Programming Executive"
- Added references to the Operand field throughout Section 16.2 "The PE Command Set"
- Updated the PROGRAM Command Algorithm (see Figure 16-9)
- Updated the mask values for All PIC32MX1XX and PIC32MX2XX devices, and DEVCFG3 for all devices (see Table 17-1)
- Updated the DCR value (see Section 17.4.3 "Calculating for "DCR" in the Checksum Formula" and Table 17-2)
- Updated the Checksum Calculation Process (see Example 17-1)
- Added these new devices to the Code Memory Size table (see Table 5-1) and the Device IDs and Revision table (see Table 18-4):
  - PIC32MX420F032H
- PIC32MX450F128L
- PIC32MX330F064HPIC32MX330F064L
- PIC32MX440F256H
   PIC32MX450F256H
- PIC32MX430F064H
- PIC32MX450F256L
   PIC32MX460F256L
- PIC32MX430F064L
- PIC32MX340F128HPIC32MX340F128L
- PIC32MX340F512H
   PIC32MX360F512H
   PIC32MX370F512H
- PIC32MX350F128H
- PIC32MX350F128L
- PIC32MX350F256H
- PIC32MX370F512L
   PIC32MX440F512H
   PIC32MX460F512L
- PIC32MX350F256L
   PIC32MX440F128H
- PIC32MX470F512H
   PIC32MX470F512L
- PIC32MX440F128L
- PIC32MX450F128H
- Added a Note to Section 18.2 "Device Code Protection bit (CP)"
- Added the EJTAG Control Register (see Register 19-1)
- Updated Section 19.2.4 "ETAP\_EJTAGBOOT Command"
- AC/DC Characteristics and Timing Requirements updates (see Table 20-1):
  - Removed parameter D112
  - Replaced Notes 1 and 2 with a new Note 1
  - Updated parameters D111, D113, D114, D031, D041, D080, D090, D012, D013, P11, P12, and P13
- Minor updates to text and formatting were incorporated through the document

## **Revision L (January 2013)**

This revision includes the following updates:

- The following sections were added or updated:
  - Section 2.1 "Devices with Dual Flash Panel and Dual Boot Regions" (new)
  - Section 4.3 "Power Requirements"
  - Section 13.0 "Initiating a Flash Row Write"
  - Section 16.1.1 "2-wire ICSP EJTAG RATE"
- Updated the Device Configuration Register Mask Values (see Table 17-1)
- The following devices were added to the Code Memory Size table and the Device IDs and Revision table (see Table 5-1 and Table 18-4):
  - PIC32MZ0256ECE064 PIC32MZ1024ECF064
  - PIC32MZ0256ECE100 PIC32MZ1024ECF100
  - PIC32MZ0256ECE124
    - E124 PIC32MZ1024ECF124
    - PIC32MZ0256ECE144 PIC32MZ1024ECF144
  - PIC32MZ0256ECF064 PIC32MZ1024ECG064
  - PIC32MZ0256ECF100 PIC32MZ1024ECG100
  - PIC32MZ0256ECF124 PIC32MZ1024ECG124
  - PIC32MZ0256ECF144 PIC32MZ1024ECG144
  - PIC32MZ0512ECE064 PIC32MZ1024ECH064
  - PIC32MZ0512ECE100 PIC32MZ1024ECH100
  - PIC32MZ0512ECE124 PIC32MZ1024ECH124
  - PIC32MZ0512ECE144 PIC32MZ1024ECH144
  - PIC32MZ0512ECF064 PIC32MZ2048ECG064
  - PIC32MZ0512ECF100 PIC32MZ2048ECG100
  - PIC32MZ0512ECF124 PIC32MZ2048ECG124
  - PIC32MZ0512ECF144 PIC32MZ2048ECG144
  - PIC32MZ1024ECE064 PIC32MZ2048ECH064
  - PIC32MZ1024ECE100 PIC32MZ2048ECH100
  - PIC32MZ1024ECE124 PIC32MZ2048ECH124
  - PIC32MZ1024ECE144 PIC32MZ2048ECH144
- Note 3 and Note 4 and the GET\_CHECKSUM and QUAD\_WORD\_PRGM commands were added to the PE Command Set (see Table 16-2)
- Added Section 16.2.15 "GET\_CHECKSUM Command"
- Added Section 16.2.16
   "QUAD\_WORD\_PROGRAM Command"
- Updated all addresses in DEVCFG Locations (see Table 18-1 and Table 18-2)
- Added Configuration Word Locations for PIC32MZ EC Family Devices (see Table 18-3)
- Updated Section 18.2 "Device Code Protection bit (CP)"
- Updated Section 18.3 "Program Write Protection bits (PWP)"
- All references to Test mode were updated to
   Programming mode throughout the document
- Minor updates to text and formatting were incorporated through the document

NOTES:

#### Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
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